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NEC Electronics Inc.

µPD78312A Family
(µPD78310A/312A/P312A)
16-/8-Bit, K-Series Microcontrollers
With Real-Time Output Ports

September 1993

Description

The µPD78310A, µPD78312A, and µPD78P312A are members of the K-Series® of microcontrollers and are designed for use in process control. They perform all the usual process control functions and are particularly well-suited for driving stepping motors and dc motors in servo loops. The processors include on-chip memory, timers, input/output registers, and a powerful interrupt handling facility. The µPD78310A/312A is constructed of high-speed CMOS circuitry and operates from a single +5-volt power supply.

The input frequency (maximum 12 MHz) is derived from an external crystal or an external oscillator. The internal processor clock is two-phase, and thus machine states are executed at a rate of 6 MHz. The shortest instructions require three states, making the minimum time 500 ns. The CPU contains a three-byte instruction prefetch queue, which allows a subsequent instruction to be fetched during execution of an instruction that does not reference memory.

Program memory is 8K bytes of mask-programmable ROM (µPD78312A only), and data memory is 256 bytes of static RAM. The µPD78310A is the ROMless version. µPD78P312A is a prototyping chip for µPD78312A. It has an on-chip 8K EPROM instead of a mask ROM.

Features

- Complete single-chip microcontroller
  - 16-bit ALU
  - 8K ROM (µPD78312A only)
  - 256 bytes RAM
  - 1-bit and 8-bit logic
- Instruction prefetch queue
- 16-bit unsigned multiply and divide
- String instructions

- Memory expansion
  - 8085A bus-compatible
  - Total 64K address space
- Large I/O capacity: up to 32 I/O port lines
- Extensive timer/counter system
  - Two 16-bit up/down counters
  - Quadrature counting
  - Two 16-bit timers
  - Free-running counter with two 16-bit capture registers
  - Pulse-width modulated outputs
  - Timebase counter
- Four-channel 8-bit A/D converter
- Two 4-bit real-time output ports
- Two nonmaskable interrupts
- Eight hardware priority interrupt levels
- Macro service facility for interrupts gives the effect of eight DMA channels
- Bidirectional serial port
  - Either UART or interface mode
  - Dedicated baud rate generator
- Watchdog timer
- Refresh output for pseudostatic RAM
- Programmable HALT and STOP modes
- One-byte call instruction
- On-chip clock generator
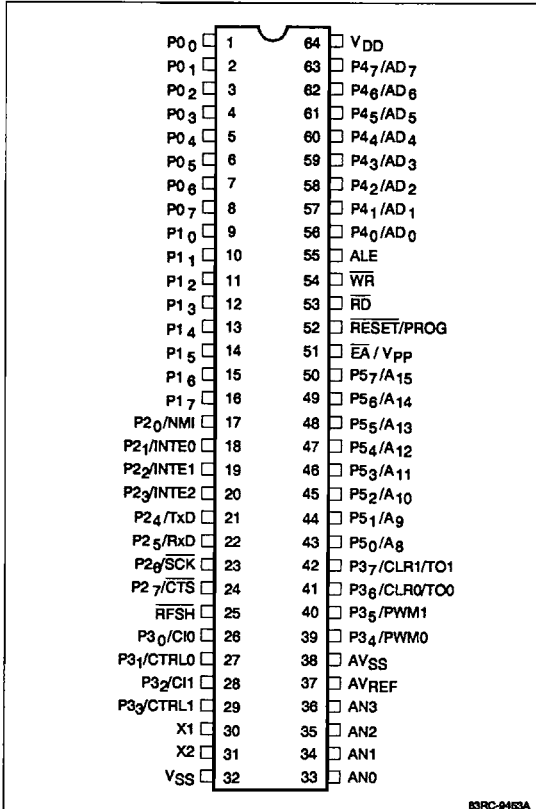- CMOS silicon gate technology
- +5-volt power supply

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K-Series is a registered trademark of NEC Electronics, Inc.

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Ordering Information

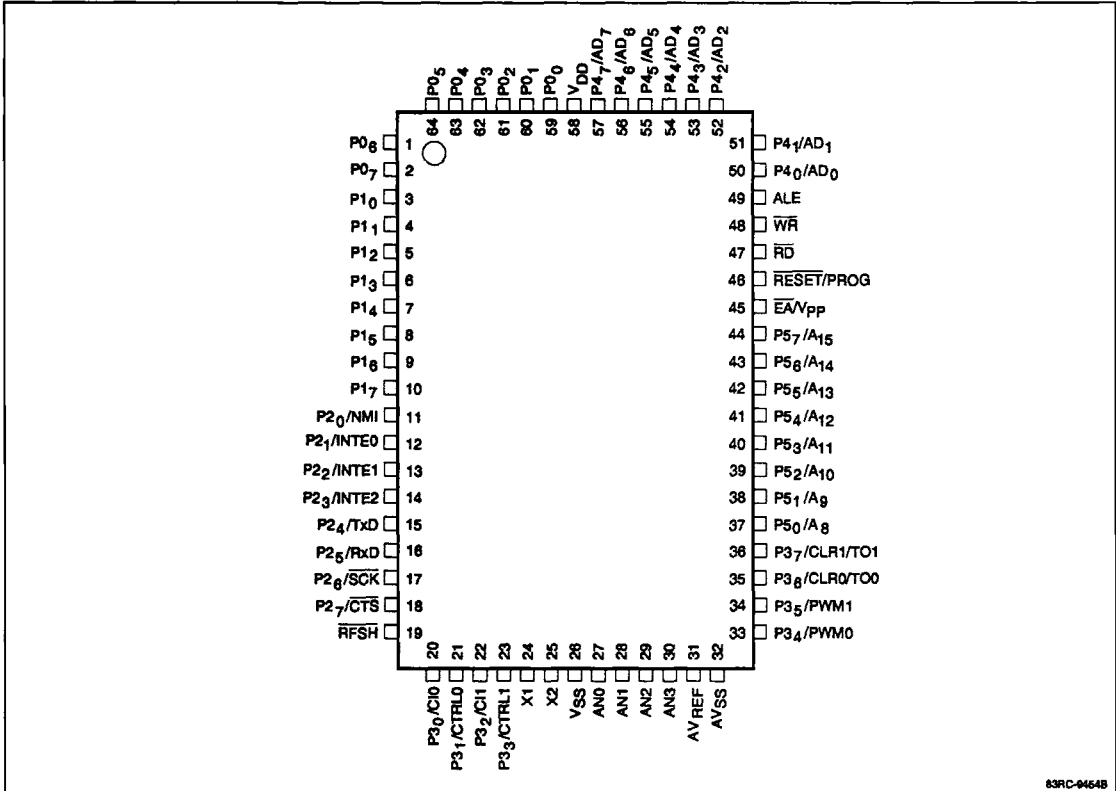| Part Number	ROM	Package	Package Drawing
μPD78310ACW μPD78312ACW-xxx μPD78P312ACW	ROMless 8K mask ROM 8K OTP ROM	64-pin plastic shrink DIP	P64C-70-750 A,C
μPD78310AGF-3BE μPD78312AGF-xxx-3BE μPD78P312AGF-3BE	ROMless 8K mask ROM 8K mask ROM	64-pin plastic QFP	P64GF-100-3B8, 3BE-1
μPD78310AGQ-36 μPD78312AGQ-xxx-36 μPD78P312AGQ-36	ROMless 8K Mask ROM 8K OTP ROM	64-pin plastic QUIP	P64GQ-100-36
μPD78310AL μPD78312AL-xxx μPD78P312AL	ROMless 8K Mask ROM 8K OTP ROM	68-pin plastic PLCC	P68L-50A1-1
μPD78P312ADW	EPROM	64-pin ceramic shrink DIP with window (350 mil)	P64DW-70-750A
μPD78P312AR	EPROM	64-pin ceramic QUIP with window	P64RQ-100-A

xxx is the ROM code number.

Pin Configurations

64-Pin Shrink DIP and QUIP, Plastic and Ceramic


```
P0_0    [ 1      64 ]  V_DD
P0_1    [ 2      63 ]  P4_7/AD_7
P0_2    [ 3      62 ]  P4_6/AD_6
P0_3    [ 4      61 ]  P4_5/AD_5
P0_4    [ 5      60 ]  P4_4/AD_4
P0_5    [ 6      59 ]  P4_3/AD_3
P0_6    [ 7      58 ]  P4_2/AD_2
P0_7    [ 8      57 ]  P4_1/AD_1
P1_0    [ 9      56 ]  P4_0/AD_0
P1_1    [ 10     55 ]  ALE
P1_2    [ 11     54 ]  WR
P1_3    [ 12     53 ]  RD
P1_4    [ 13     52 ]  RESET/PROG
P1_5    [ 14     51 ]  EA/V_PP
P1_6    [ 15     50 ]  P5_7/A_15
P1_7    [ 16     49 ]  P5_6/A_14
P2_0/NMI    [ 17  48 ]  P5_5/A_13
P2_1/INTE0  [ 18  47 ]  P5_4/A_12
P2_2/INTE1  [ 19  46 ]  P5_3/A_11
P2_3/INTE2  [ 20  45 ]  P5_2/A_10
P2_4/TxD    [ 21  44 ]  P5_1/A_9
P2_5/RxD    [ 22  43 ]  P5_0/A_8
P2_6/SCK    [ 23  42 ]  P3_7/CLR1/TO1
P2_7/CTS    [ 24  41 ]  P3_6/CLR0/TO0
RFSH        [ 25  40 ]  P3_5/PWM1
P3_0/CI0    [ 26  39 ]  P3_4/PWM0
P3_1/CTRL0  [ 27  38 ]  AV_SS
P3_2/CI1    [ 28  37 ]  AV_REF
P3_3/CTRL1  [ 29  36 ]  AN3
X1          [ 30  35 ]  AN2
X2          [ 31  34 ]  AN1
V_SS        [ 32  33 ]  AN0
```

83RC-9453A

Pin Configurations (cont)

64-Pin Plastic QFP

Left side pins (top to bottom):
- PO6 — 1
- PO7 — 2
- P10 — 3
- P11 — 4
- P12 — 5
- P13 — 6
- P14 — 7
- P15 — 8
- P16 — 9
- P17 — 10
- P20/NMI — 11
- P21/INTE0 — 12
- P22/INTE1 — 13
- P23/INTE2 — 14
- P24/TxD — 15
- P25/RxD — 16
- P26/SCK — 17
- P27/CTS — 18
- RFSH — 19

Top side pins (left to right, 64 to 52):
- PO5 — 64
- PO4 — 63
- PO3 — 62
- PO2 — 61
- PO1 — 60
- PO0 — 59
- VDD — 58
- P47/AD7 — 57
- P46/AD6 — 56
- P45/AD5 — 55
- P44/AD4 — 54
- P43/AD3 — 53
- P42/AD2 — 52

Right side pins (top to bottom, 51 to 33):
- 51 — P41/AD1
- 50 — P40/AD0
- 49 — ALE
- 48 — WR
- 47 — RD
- 46 — RESET/PROG
- 45 — EA/Vpp
- 44 — P57/A15
- 43 — P56/A14
- 42 — P55/A13
- 41 — P54/A12
- 40 — P53/A11
- 39 — P52/A10
- 38 — P51/A9
- 37 — P50/A8
- 36 — P37/CLR1/TO1
- 35 — P36/CLR0/TO0
- 34 — P35/PWM1
- 33 — P34/PWM0

Bottom side pins (left to right, 20 to 32):
- P30/CI0 — 20
- P31/CTRL0 — 21
- P32/CI1 — 22
- P33/CTRL1 — 23
- X1 — 24
- X2 — 25
- VSS — 26
- AN0 — 27
- AN1 — 28
- AN2 — 29
- AN3 — 30
- AVREF — 31
- AVSS — 32

5a

83RC-9454B

3

Pin Configurations (cont)

68-Pin PLCC (Plastic Leaded Chip Carrier)

Top pins (left to right, pins 9 down to 1, then 68 to 61):
PO6 (9), PO5 (8), PO4 (7), PO3 (6), PO2 (5), PO1 (4), PO0 (3), NC (2), VSS (1), VDD (68), P47/AD7 (67), P46/AD6 (66), P45/AD5 (65), P44/AD4 (64), P43/AD3 (63), P42/AD2 (62), P41/AD1 (61)

Left side (pins 10–26):
Pin	Signal
10	PO7
11	P10
12	P11
13	P12
14	P13
15	P14
16	P15
17	P16
18	P17
19	P20/NMI
20	P21/INTE0
21	P22/INTE1
22	P23/INTE2
23	P24/TxD
24	P25/RxD
25	P26/SCK
26	P27/CTS

Right side (pins 60–44):
Pin	Signal
60	P40/AD0
59	ALE
58	WR
57	RD
56	RESET/PROG
55	EA/VPP
54	P57/A15
53	P56/A14
52	P55/A13
51	P54/A12
50	P53/A11
49	P52/A10
48	P51/A9
47	NC
46	P50/A8
45	P37/CLR1/TO1
44	P36/CLR0/TO0

Bottom pins (left to right, pins 27–43):
RFSH (27), P30/CI0 (28), P31/CTRL0 (29), P32/CI1 (30), P33/CTRL1 (31), X1 (32), X2 (33), VSS (34), VSS (35), AN0 (36), AN1 (37), AN2 (38), AN3 (39), AVREF (40), AVSS (41), P34/PWM0 (42), P35/PWM1 (43)

83RC-9455B

4

Pin Identification

Symbol	Function
AN0 - AN3	A/D converter inputs
ALE	Address latch enable output
$\overline{EA}/V_{PP}$	External access control input; programming voltage
$P0_7 - P0_0$	I/O port 0
$P1_7 - P1_0$	I/O port 1
$P2_0$/NMI	Nonmaskable interrupt input
$P2_1 - P2_3$/INTE0 - INTE2	Maskable interrupt inputs
$P2_4$/TxD	I/O port 2; serial transmit output
$P2_5$/RxD	I/O port 2; serial receive input
$P2_6/\overline{SCK}$	I/O port 2; serial clock output
$P2_7/\overline{CTS}$	I/O port 2; clear to send input
$P3_0$/CI0	Up/down counter 0 input
$P3_1$/CTRL0	Up/down counter 0 control input
$P3_2$/CI1	Up/down counter 1 input
$P3_3$/CTRL1	Up/down counter 1 control input
$P3_4$/PWM0	I/O port 3; pulse width modulated output 0
$P3_5$/PWM1	I/O port 3; pulse width modulated output 1
$P3_6$/CLR0/TO0	I/O port 3; counter 0 clear input timer 0 output
$P3_7$/CLR1/TO1	I/O port 3; counter 1 clear input; timer 1 output
$P4_7 - P4_0/AD_7 - AD_0$	I/O port 4; external address/data bus
$P5_7 - P5_0/A_{15} - A_8$	I/O port 5; high address byte output
$\overline{RD}$	Read strobe output
$\overline{RESET}$/PROG	External reset input; PROM programming mode
$\overline{RFSH}$	Refresh output
$\overline{WR}$	Write strobe output
X1	External crystal or external clock input
X2	External crystal
AV_{REF}	A/D reference voltage
AV_{SS}	Analog ground
V_{DD}	Power supply
V_{SS}	Power return

Pin Functions

AN0 - AN3 (A/D Converter Inputs). AN0 - AN3 are the four program selectable input channels for the A/D converter.

ALE (Address Latch Enable). ALE is the address latch enable. It is to be used by external circuitry to latch the low-order 8 address bits during the first part of a read or write cycle.

$\overline{EA}/V_{PP}$. On μPD78312A, a low on $\overline{EA}$ enables use of external memory in place of on-chip ROM. The $\overline{EA}$ pin must be low on μPD78310A. On the μPD78P312A, this pin is used for programming voltage. In normal operation, it must be connected to V_{DD}.

$P0_7 - P0_0$ (Port 0). Port 0 consists of 8 bits, individually programmable for input/output or two 4-bit real-time (timer controlled) output ports.

$P1_7 - P1_0$ (Port 1). Port 1 consists of 8 bits, individually programmable for input/output.

$P2_0$/NMI (Port 2; Nonmaskable Interrupt). Port $P2_0$ is dedicated to NMI, the nonmaskable external interrupt request.

$P2_1 - P2_3$/INTE0-INTE2 (Port 2; Maskable Interrupts). Ports $P2_1 - P2_3$ are dedicated to INTE0, INTE1, and INTE2, the maskable external interrupt requests.

$P2_4$/TxD (Port 2; Serial Transmit). $P2_4$ is an I/O port bit or the transmitted serial data output.

$P2_5$/RxD (Port 2; Serial Receive). $P2_5$ is an I/O port bit or the received serial data input.

$P2_6/\overline{SCK}$ (Port 2; Serial Clock). $P2_6$ is an I/O port bit or the serial shift clock output.

$P2_7/\overline{CTS}$ (Port 2; Clear to Send). $P2_7$ is an I/O port bit or clear-to-send input (external serial transmission control) in the asynchronous communication mode. In the serial I/O interface mode, it becomes the serial receive clock I/O pin.

5a

P3₀/CI0 (Port 3; Counter 0). Port $P3_0$ is dedicated to CI0, the external count input for up/down counter 0.

P3₁/CTRL0 (Port 3; Counter 0 Control). Port $P3_0$ is dedicated to CTRL0, the external control input for up/down counter 0.

P3₂/CI1 (Port 3; Counter 1). Port $P3_2$ is dedicated to CI1, the external count input for up/down counter 1.

P3₃/CTRL1 (Port 3; Counter 1 Control). Port $P3_3$ is dedicated to CTRL1, the external control input for up/down counter 1.

P3₄/PWM0 (Port 3; Pulse Width 0). $P3_4$ is an I/O port bit or the pulse-width modulated output 0.

P3₅/PWM1 (Port 3; Pulse Width 1). $P3_5$ is an I/O port bit or the pulse-width modulated output 1.

P3₆/CLR0/TO0 (Port 3; Counter 0 Clear; Timer 0). $P3_6$ is an I/O port bit, or the clear input for up/down counter 0, or the timer 0 flip-flop output.

P3₇/CLR1/TO1 (Port 3; Counter 1 Clear; Timer 1). $P3_7$ is an I/O port bit, or the clear input for up/down counter 1, or the timer 1 flip-flop output.

P4₀ - P4₇/AD₀ - AD₇ (Port 4; External Address/Data Bus). Port 4 consists of 8 bits, programmable as a unit for input or output, or as the multiplexed address/data bus if external memory or external interface circuitry is used. The port is controlled by the memory mapping register. If the $\overline{EA}$ pin is low, port 4 is always an address/data bus.

P5₀ - P5₇/A₈ - A₁₅ (Port 5; High-Address Byte). Port 5 consists of 8 bits, individually programmable for input or output, or the high-order address bits for external memory. Under control of the memory mask register, bits $P5_3$ - $P5_0$ are used for 4K memory expansion, bits $P5_5$ - $P5_0$ for 16K memory expansion, or bits $P5_7$ - $P5_0$ for 56K memory expansion. If the $\overline{EA}$ pin is low, port 5 is always the high-order address bus.

$\overline{RD}$ (Read Strobe). $\overline{RD}$ is the read strobe output. It is to be used by external memory (or data registers) to place data on the I/O bus during a read operation.

$\overline{RESET}$/PROG. This pin is used for the external reset input. A low level sets all registers to their specified reset values. During programming of the *μ*PD78P312A, this pin is used to place the device into PROM programming mode.

$\overline{RFSH}$ (Refresh). $\overline{RFSH}$ is the refresh pulse output to be used for external pseudostatic RAM.

$\overline{WR}$ (Write Strobe). $\overline{WR}$ is the write strobe output. It is to be used by external memory (or data registers) to latch data from the I/O bus during a write operation.

X1, X2 (External Crystal or Clock Input). X1 and X2 are the external oscillator inputs or the connections for an external crystal. If an external clock is used, it is connected to X1 and its inverse is connected to X2. The system clock frequency is half the input frequency.
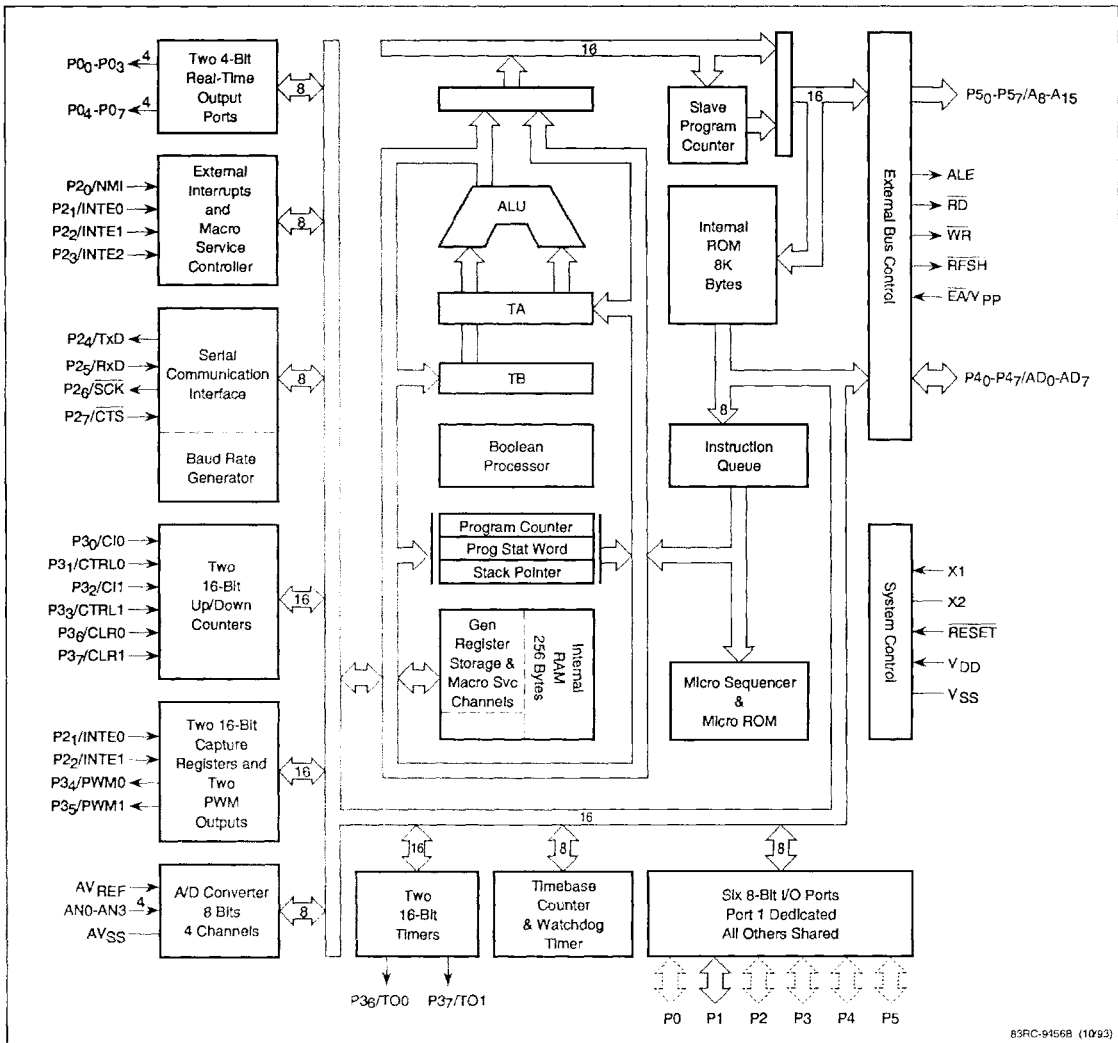
AV_{REF} (A/D Reference Voltage). AV_{REF} is the reference voltage input for the A/D converter.

AV_{SS} (Analog Ground). AV_{SS} is the analog ground pin.

V_{DD} (Power Supply). V_{DD} is the positive power supply input.

V_{SS} (Power Return). V_{SS} is the power supply return, normally ground.

Block Diagram

Block diagram showing the internal architecture of the μPD78312A Family microcontroller, including:
- P0₀-P0₃, P0₄-P0₇ — Two 4-Bit Real-Time Output Ports
- P2₀/NMI, P2₁/INTE0, P2₂/INTE1, P2₃/INTE2 — External Interrupts and Macro Service Controller
- P2₄/TxD, P2₅/RxD, P2₆/SCK, P2₇/CTS — Serial Communication Interface, Baud Rate Generator
- P3₀/CI0, P3₁/CTRL0, P3₂/CI1, P3₃/CTRL1, P3₆/CLR0, P3₇/CLR1 — Two 16-Bit Up/Down Counters
- P2₁/INTE0, P2₂/INTE1, P3₄/PWM0, P3₅/PWM1 — Two 16-Bit Capture Registers and Two PWM Outputs
- AV REF, AN0-AN3, AVSS — A/D Converter 8 Bits 4 Channels
- ALU, TA, TB, Boolean Processor, Program Counter, Prog Stat Word, Stack Pointer, Gen Register Storage & Macro Svc Channels, Internal RAM 256 Bytes
- Slave Program Counter, Internal ROM 8K Bytes, Instruction Queue, Micro Sequencer & Micro ROM
- External Bus Control — P5₀-P5₇/A₈-A₁₅, ALE, RD, WR, RFSH, EA/VPP, P4₀-P4₇/AD₀-AD₇
- System Control — X1, X2, RESET, VDD, VSS
- Two 16-Bit Timers — P3₆/TO0, P3₇/TO1
- Timebase Counter & Watchdog Timer
- Six 8-Bit I/O Ports, Port 1 Dedicated, All Others Shared — P0, P1, P2, P3, P4, P5

83RC-9456B (10/93)

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7

FUNCTIONAL DESCRIPTION

On-chip features designed to facilitate process control include two 16-bit timers, quadrature counting, two 16-bit up/down counters, two pulse-width modulated outputs, a free-running counter with two capture registers, two 4-bit real-time (timer-controlled) output ports, an 8-bit A/D converter with four input channels, a timebase counter to generate widely spaced interrupts, and a watchdog timer to guard against infinite program loops.

In addition, a serial I/O port can be used in either an interface mode or an asynchronous communication mode. HALT and STOP modes are provided to conserve power at times when CPU action is not required.

All I/O, timer, and control registers are defined as special function registers and assigned addresses in the top 256 bytes of memory. The special function registers may be operated on directly by many of the arithmetic, logic, and move instructions of the CPU. Table 1 describes the registers.

Addressing

The μPD78312A family features 1-byte addressing of the special function registers and 1-byte addressing of the internal RAM. There are nine modes of addressing main memory, including autoincrement, autodecrement, indexing, and double indexing. There are 8- and 16-bit immediate operands.

External Memory

External memory (figure 1) is supported by I/O port 4, an 8-bit multiplexed address/data bus. The memory mapping register controls the size of external memory as well as the number of additional wait states. High-order address bits are taken from I/O port 5 as required. No bits are required for 256 bytes of external memory; bits $P5_3$ - $P5_0$ are used for 4K bytes, $P5_5$ - $P5_0$ for 16K bytes, and $P5_7$ - $P5_0$ for 56K bytes. Any remaining port 5 bits are available for I/O.

Refresh

The μPD78312A has a refresh signal for use with the pseudostatic RAM. The refresh cycle can be set to one of four intervals ranging from 2.67 to 21.3 μs. The refresh is timed to follow a read or write operation so that there is no interference.

Figure 1. Memory Map

83RC-9457A (10/93)
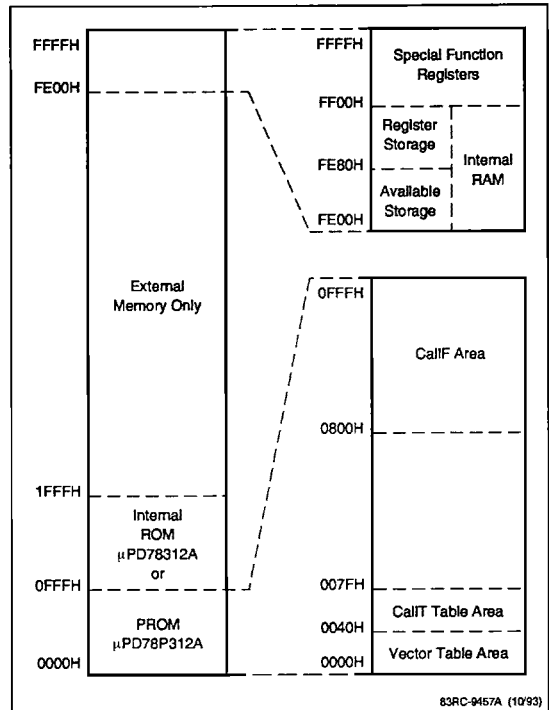
General Registers

The CPU has sixteen 8-bit registers (figure 2) that can also be used in pairs to function as 16-bit registers. A complete set of 16 general registers is mapped into each of 8 program-selectable register banks stored in RAM. Three bits in the PSW specify which of the register banks is active at any given time. Each register bank has two program-selectable accumulators.

The general registers of the μPD78312A have both absolute and functional names. AX is the functional name for the accumulator. Setting the RSS bit in the PSW to 1 transfers the AX and BC registers from their normal RP0 and RP1 positions to RP2 and RP3 as shown in figure 2. This adds considerable programming flexibility.

Figure 2. Register Designation and Storage
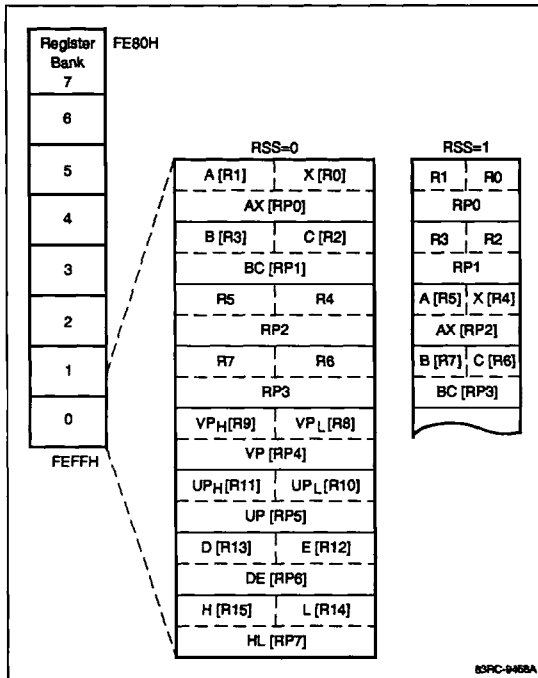
Program Status Word

Following is the program status word format.

0	RB₂	RB₁	RB₀	0	0	IE	0
15							8

S	Z	RSS	AC	UF	P/V	SUB	CY
7							0
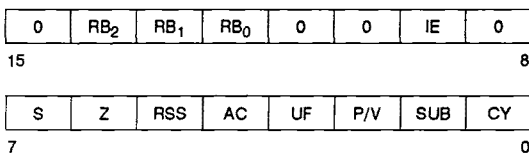
RB₂ - RB₀	Active register bank number
IE	Interrupt enable
S	Sign (1 if last result was negative)
Z	Zero (1 if last result was zero)
RSS	Register set select
AC	Auxiliary carry (carry out of 3rd bit)
UF	User flag
P/V	Parity or arithmetic overflow
SUB	Subtract (1 if last operation was subtract)
CY	Carry

Input/Output

All ports may be used for either latched output or high-impedance input. All ports except port 4 are bit-programmable for input or output. Port 0 is used for real-time or normal I/O. Port 1 is used for normal I/O. The low nibble of ports 2 and 3 is always used for control and the high nibble for control or normal I/O. Port 4 is used for the external address/data bus or byte-programmable I/O. Port 5 is used for the high bits of the external address or for normal I/O.

Real-Time Output Port

The real-time output port shares pins with I/O port 0. The high and low nibbles are treated separately or together. Data is transferred from a buffer to the port latches on either a timer or software command.

Serial Port

The serial port can operate in UART or interface mode with the baud rate and byte format under program control. The serial port also includes a dedicated baud rate generator.

Pulse-Width Modulated Outputs

The two independent pulse-width modulated outputs are controlled by two 16-bit modulus registers and counters. There are four programmable repetition rates ranging from 91.6 Hz to 23.4 MHz. Figure 3 shows one of these outputs.

Timers

The µPD78312A has two 16-bit timers. The inputs to these timers may be the internal clock divided by 6; 12(TM0) or 128. Each timer has an associated modulus register to store the timer count. The timer counts down to zero, sets a flag, reloads from the modulus register, and then counts down again. The timer flags can be used under program control to generate interrupt requests and/or a square-wave output. TM0 also functions optionally as two one-shot timers.

Figure 4 is a diagram of the interval timers.

There is a free-running counter that counts the internal clock divided by 4 or by 16. The counter has two 16-bit capture registers. Capture is triggered by an external interrupt request or by the up/down counter clock.

The timebase counter generates a signal at one of four intervals ranging from 170 µs to 175 ms. The signal can be used to generate an interrupt request and/or an up/down counter capture.

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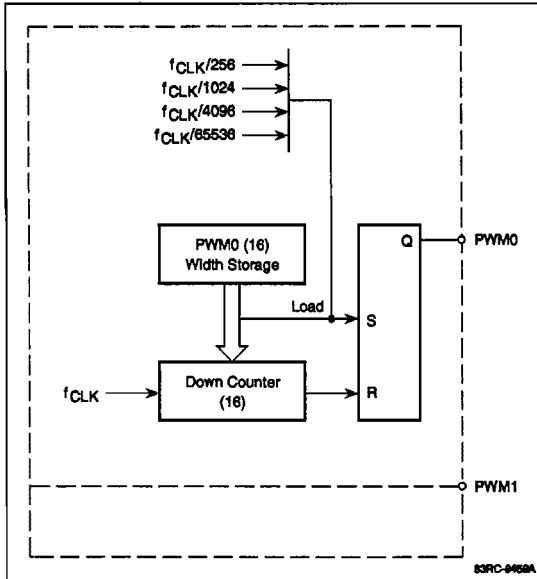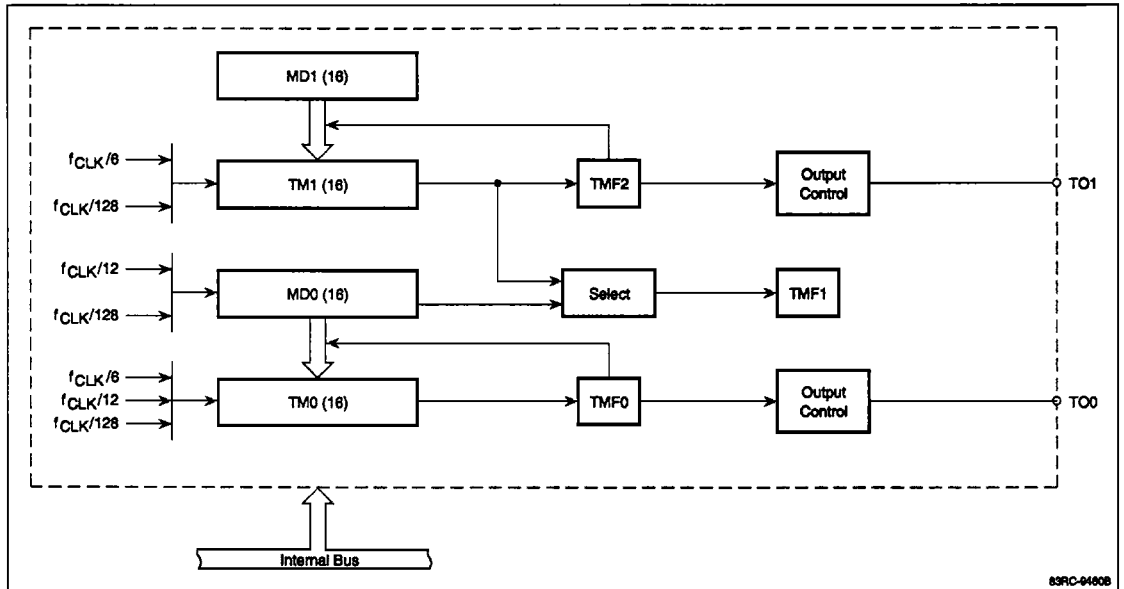
Figure 3. Pulse-Width Modulated Output

Figure 4. Timer Block Diagram

Up/Down Counters

The µPD78312A has two 16-bit up/down counters, each of which has two capture/compare registers. There are three modes of operation: compare and interrupt, capture on external command, and capture on timebase counter command. There are five sources of counts: the internal clock divided by 3, the external clock, external independent up and down inputs, external clock with direction control, and external clock with automatic up/down discrimination. Figure 5 shows an up/down counter.

Figure 5.   Up/Down Counter Block Diagram

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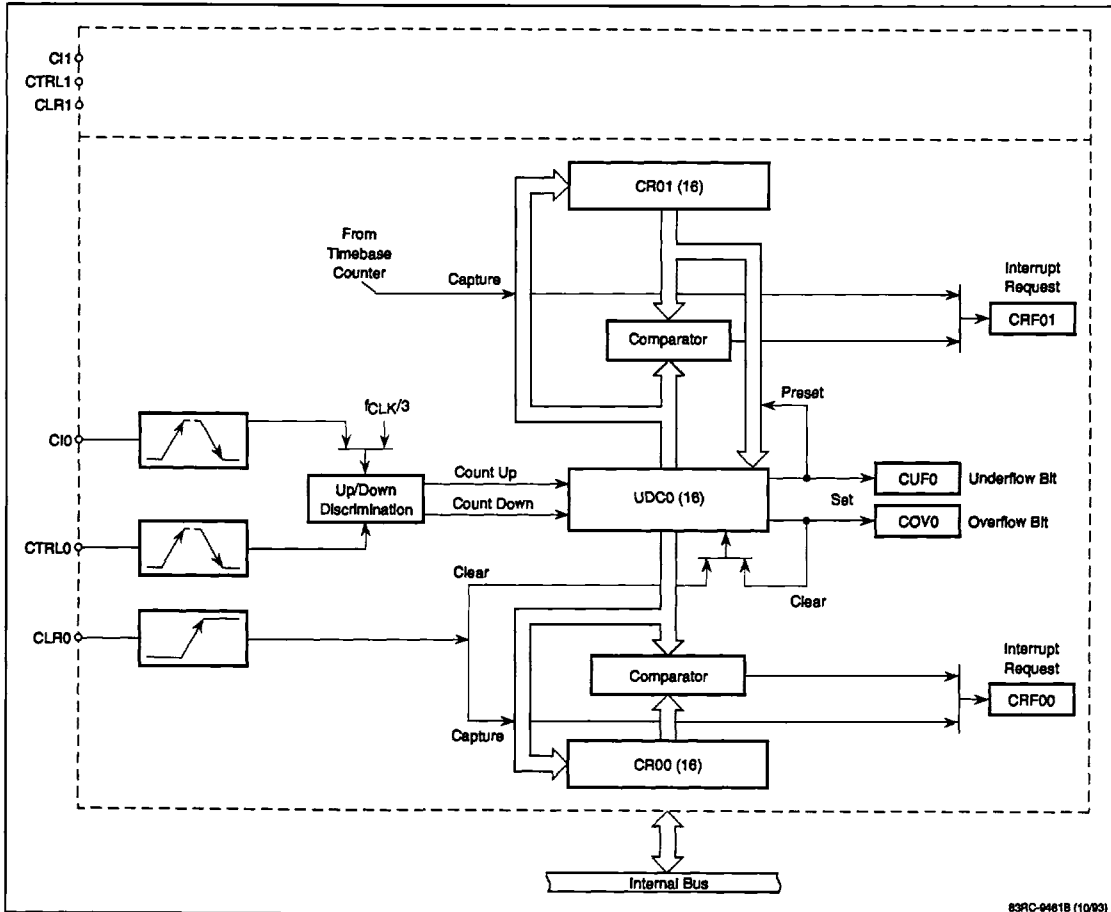
Quadrature Counting

The two up/down counters, UDC0 and UDC1, have an optional quadrature counting mode, which is activated by specifying mode 4 in the counter unit input mode register, CUIM. It is designed to count the output of a two-phase pulsed optical shaft angle encoder. The input for phase A is the CI0 (or CI1) pin, and the input for phase B is the CTRL0 (or CTRL1) pin. The counter UDC0 (or UDC1) is incremented or decremented at both positive and negative transitions of both input signals. Whether it is incremented or decremented is dependent upon the relative phase of the two signals as illustrated in figure 6.

Figure 6. Counter Operation (Mode 4)
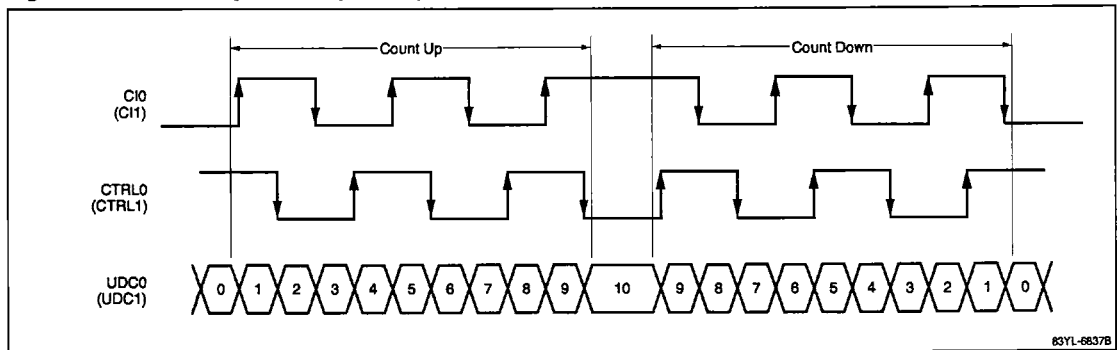
Standby Modes

HALT and STOP modes conserve power when CPU action is not required. In HALT mode, the CPU stops and the clock continues to run. Maskable interrupts can restart the CPU.

In STOP mode, the CPU and clock are both stopped. A RESET pulse or the nonmaskable external interrupt is required to restart them. There is also the option of slowing the system clock by a factor of four. The standby control register controls the standby modes and is a protected location written to only by a special instruction.

Watchdog Timer

The watchdog timer protects against inadvertent program loops. A nonmaskable interrupt occurs if the timer is not reset before a timeout occurs. There are four program-selectable intervals ranging from 5.5 to 349.3 ms. The watchdog timer can be disabled by software. The watchdog timer mode register controls the watchdog timer and is a protected location written to only by a special instruction.

A/D Converter

The A/D converter has four input channels and can operate in either scan or select mode. The A/D converter performs 8-bit successive approximation conversions, has a 30-*μ*s conversion time, and is triggered either internally or externally. The A/D converter includes an on-chip sample and hold amplifier.

Interrupts

There are two nonmaskable interrupt sources: the external nonmaskable interrupt and the watchdog timer. Their relative priorities are software selectable.

There are eight hardware priority interrupt levels, level 0 having the highest priority and level 7 the lowest. The 15 maskable interrupt sources (table 2) are divided into five groups, and each group can, under program control, be assigned to any one of the priority levels.

Interrupts may be serviced by routines entered either by vectoring or by context switching. Context switching automatically saves all the general registers, the

program status word, and the program counter. Figure 7 illustrates the mechanism of context switching.

Finally, an optional macro service function transfers data between any one special function register and memory without program intervention.
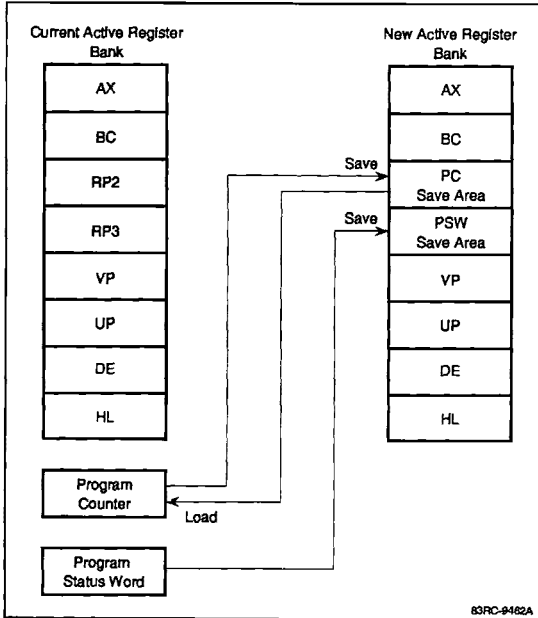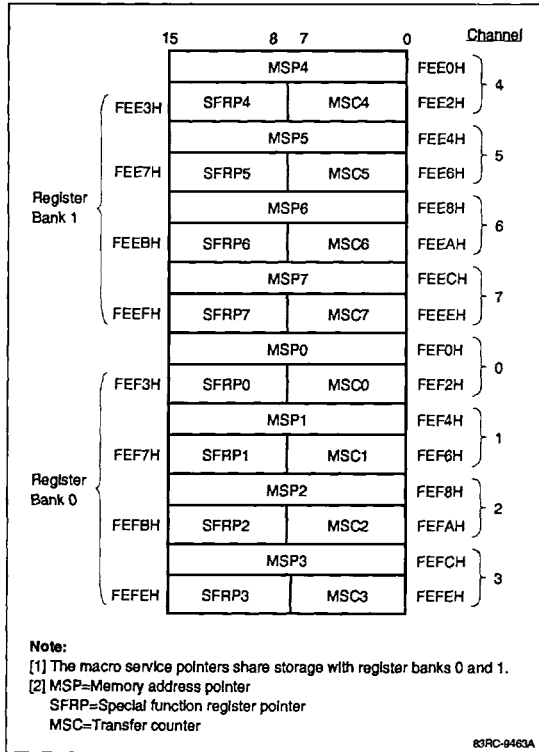
Figure 7. Hardware Context Switching

Figure 7. Hardware Context Switching

Figure 8. Macroservice Pointer Addresses

Figure 8. Macroservice Pointer Addresses

Note:
[1] The macro service pointers share storage with register banks 0 and 1.
[2] MSP=Memory address pointer
SFRP=Special function register pointer
MSC=Transfer counter

5a

Macro Service

The macro service controller can be programmed to perform word or byte transfers. It can transfer data from a special function register to memory or from memory to a special function register. Transfer events are triggered by interrupt requests and take place without software intervention.

There are eight macro service channels; channel control information is stored in RAM. This information (figure 8) consists of a 16-bit memory address (optionally incremented at each transfer), and 8-bit special function register designator, and an 8-bit transfer counter (decremented at each transfer). When the count equals 0, a context switch or vectored interrupt occurs.

Table 1. Special Function Registers

Address	Register (SFR)	Symbol		R/W	16-Bit Transfer	State After Reset
FF00H	I/O port 0	P0		R/W	No	Undefined
FF01H	I/O port 1	P1		R/W	No	Undefined
FF02H	I/O port 2	P2		R/W (Note 1)	No	Undefined
FF03H	I/O port 3	P3		R/W (Note 1)	No	Undefined
FF04H	I/O port 4	P4		R/W	No	Undefined
FF05H	I/O port 5	P5		R/W	No	Undefined
FF08H FF09H	Capture/compare register 00	CR00L CR00H	CR00	R/W	Yes	Undefined
FF0AH FF08H	Capture/compare register 01	CR01L CR01H	CR01	R/W	Yes	Undefined
FF0CH FF0DH	Capture/compare register 10	CR10L CR10H	CR10	R/W	Yes	Undefined
FF0EH FF0FH	Capture/compare register 11	CR11L CR11H	CR11	R/W	Yes	Undefined
FF10H F11H	Capture register 0 (from FRC)	CPT0L CPT0H	CPT0	R/W	Yes	Undefined
FF12H FF13H	Capture register 1 (from FRC)	CPT1L CPT1H	CPT1	R/W	Yes	Undefined
FF14H FF15H	PWM register 0 (duration)	PWM0L PWM0H	PWM0	R/W	Yes	Undefined
FF16H FF17H	PWM register 1 (duration)	PWM1L PWM1H	PWM1	R/W	Yes	Undefined
FF1CH FF1DH	Presettable up/down counter 0	UDC0L UDC0H	UDC0	R/W	Yes	Undefined
FF1EH FF1FH	Presettable up/down counter 1	UDC1L UDC1H	UDC1	R/W	Yes	Undefined
FF20H	Port 0 mode register	PM0		R/W	No	FFH
FF21H	Port 1 mode register	PM1		R/W	No	FFH
FF22H	Port 2 mode register	PM2		R/W (Note 1)	No	FFH
FF23H	Port 3 mode register	PM3		R/W (Note 1)	No	FFH
FF25H	Port 5 mode register	PM5		R/W	No	FFH
FF32H	Port 2 mode control register	PMC2		R/W	No	0FH
FF33H	Port 3 mode control register	PMC3		R/W	No	0FH
FF38H	Real-time output port control register	RTPC		R/W	No	08H
FF3AH FF3BH	Port 0 buffer register (Note 2)	P0L P0H		R/W	No	Undefined
FF40H	Memory expansion mode register	MM		R/W	No	30H
FF41H	Refresh mode register	RFM		R/W	No	10H
FF42H	Watchdog timer mode register	WDM		R/W	No	00H
FF44H	Standby control register	STBC		R/W	No	2nH (Note 3)
FF46H	Timebase mode register	TBM		R/W	No	00H
FF48H	External interrupt mode register	INTM		R/W	No	00H
FF4AH	In-service priority register	ISPR		R	No	00H
FF4EH	CPU control word	CCW		R/W	No	00H

Table 1. Special Function Registers (cont)

Address	Register (SFR)	Symbol		R/W	16-Bit Transfer	State After Reset
FF50H	Serial communication mode register	SCM		R/W	No	00H
FF52H	Serial communication control register	SCC		R/W	No	00H
FF53H	Baud rate generator	BRG		R/W	No	00H
FF56H	Serial communication receive buffer	RXB		R	No	Undefined
FF57H	Serial communication transmit buffer	TXB		W	No	Undefined
FF60H	Free-running counter control register	FRCC		R/W	No	00H
FF64H	Capture mode register	CPTM		R/W	No	00H
FF66H	PWM mode register	PWMM		R/W	No	00H
FF68H	A/D converter mode register	ADM		R/W	No	00H
FF6AH	A/D converter result register	ADCR		R	No	Undefined
FF70H	Count unit input mode register	CUIM		R/W	No	00H
FF72H	Up/down counter control register 0	UDCC0		R/W	No	00H
FF74H	Capture/compare control register	CRC		R/W	No	00H
FF7AH	Up/down counter control register 1	UDCC1		R/W	No	00H
FF80H	Timer 0 control register	TMC0		R/W	No	00H
FF82H	Timer 1 control register	TMC1		R/W	No	00H
FF88H FF89H	Timer 0	TM0L TM0H	TM0	R/W	Yes	Undefined
FF8AH FF8BH	Modulus/timer register 0	MD0L MD0H	MD0	R/W	Yes	Undefined
FF8CH FF8DH	Timer 1	TM1L TM1H	TM1	R/W	Yes	Undefined
FF8EH FF8FH	Modulus register 1	MD1L TM1H	MD1	R/W	Yes	Undefined
FFB0H to FFBFH	External area (Note 4)					
FFC0H	CRF00 interrupt control Up/down counter 0	CRIC00		R/W	No	47H
FFC1H	CRF00 macro service control Up/down counter 0	CRMS00		R/W	No	Undefined
FFC2H	CRF01 interrupt control Up/down counter 0	CRIC01		R/W	No	47H
FFC4H	CRF10 Interrupt control Up/down counter 1	CRIC10		R/W	No	47H
FFC5H	CRF10 macro service control Up/down counter 1	CRMS10		R/W	No	Undefined
FFC6H	CRF11 interrupt control Up/down counter 1	CRIC11		R/W	No	47H
FFC8H	EXIF0 interrupt control External interrupt INTE0	EXIC0		R/W	No	47H
FFC9H	EXIF0 macro service control External interrupt INTE0	EXMS0		R/W	No	Undefined
FFCAH	EXIF1 interrupt control External interrupt INTE1	EXIC1		R/W	No	47H

5a

Table 1. Special Function Registers (cont)

Address	Register (SFR)	Symbol	R/W	16-Bit Transfer	State After Reset
FFCBH	EXIF1 macro service control External interrupt INTE1	EXMS1	R/W	No	Undefined
FFCCH	EXIF2 interrupt control External interrupt INTE2	EXIC2	R/W	No	47H
FFCDH	EXIF2 macro service control External interrupt INTE2	EXMS2	R/W	No	Undefined
FFCEH	TMF0 interrupt control Timer flag	TMIC0	R/W	No	47H
FFCFH	TMF0 macro service control Timer flag	TMMS0	R/W	No	Undefined
FFD0H	TMF1 interrupt control Timer flag	TMIC1	R/W	No	47H
FFD1H	TMF1 macro service control Timer flag	TMMS1	R/W	No	Undefined
FFD2H	TMF2 interrupt control Timer flag	TMIC2	R/W	No	47H
FFD3H	TMF2 macro service control Timer flag	TMMS2	R/W	No	Undefined
FFDAH	Receive error interrupt control Serial port	SEIC	R/W	No	47H
FFDCH	Receive interrupt control Serial port	SRIC	R/W	No	47H
FFDDH	Receive macro service control Serial port	SRMS	R/W	No	Undefined
FFDEH	Transmit interrupt control Serial port	STIC	R/W	No	47H
FFDFH	Transmit macro service control Serial port	STMS	R/W	No	Undefined
FFE0H	A/D converter interrupt control	ADIC	R/W	No	47H
FFE1H	A/D converter macro service control	ADMS	R/W	No	Undefined
FFE2H	Timebase counter interrupt control	TBIC	R/W	No	47H

Notes:

(1) Bits 0-3 of port 2 and of port 3 are read-only.

(2) P0H and P0L are 4-bit buffer registers used to store data to be loaded into the high and low nibbles of the real-time output (P0). The high order 4 bits of P0H and the low order 4 bits of P0L are used.

(3) Bit 3 of the STBC is not affected by $\overline{\text{RESET}}$ (n = 0 or 8).

(4) External registers interfaced with these addresses can be accessed by special function register addressing.

Table 2.   Interrupt Sources and Vector Addresses

	Default Priority	Mnemonic	Interrupt Source	Macroservice	Vector
Software	—	BRK	Break instruction	No	003EH
Nonmaskable Interrupts		NMI	External nonmaskable interrupt	No	0002H
	—	WDT	Watchdog timer	No	000AH
Maskable interrupts	0	CRF00	Up/down counter 0	Yes	001AH
	1	CRF01	Up/down counter 0	No	001CH
	2	CRF10	Up/down counter 1	Yes	001EH
	3	CRF11	Up/down counter 1	No	0020H
	4	EXIF0	External interrupt 0	Yes	0004H
	5	EXIF1	External interrupt 1	Yes	0006H
	6	EXIF2	External interrupt 2	Yes	0008H
	7	TMF0	Timer flag 0	Yes	000EH
	8	TMF1	Timer flag 1	Yes	0010H
	9	TMF2	Timer flag 2	Yes	0012H
	10	SEF	Serial port error	No	0022H
	11	SRF	Serial port receive buffer	Yes	0024H
	12	STF	Serial port transmit buffer	Yes	0026H
	13	ADF	A/D converter done flag	Yes	0028H
	14	TBF	Timebase counter flag	No	000CH
Reset	—	RESET	External reset line	—	0000H

5a

ELECTRICAL SPECIFICATIONS

Absolute Maximum Ratings

$T_A = +25°C$

Power supply voltage V_{DD}	−0.5 to +7.0 V
Reference voltage, AV_{REF}	−0.5 V to V_{DD} +0.3 V
Power supply return, AV_{SS}	−0.5 to +0.5 V
Input voltage, V_{I1} (except $\overline{RESET}$ of μPD78P312A)	−0.5 to + V_{DD} + 0.5
Input voltage, V_{I2} ($\overline{RESET}$ of μPD78P312A only)	−0.5 to +13.5 V
Output voltage, V_O	−0.5 to V_{DD} +0.5 V
Output current, low; I_{OL} (single pin)	4 mA
Output current, low; I_{OL}; total, all output pins (μPD78312/310A)	100 mA
Output current, low; I_{OL}; total, all output pins (μPD78P312A)	60 mA
Output current, high; I_{OH} (single pin)	−1 mA
Output current, high; I_{OH}; total, all output pins (μPD78312/310A)	−25 mA

Absolute Maximum Ratings (cont)

Output current, high; I_{OH}; total, all output pins (μPD78P312A)	−15 mA
Operating temperature, T_{OPT}	−10 to +70°C
Storage temperature, T_{STG}	−65 to +150°C

Exposure to Absolute Maximum Ratings for extended periods may affect device reliability; exceeding the ratings could cause permanent damage. The device should be operated within the limits specified under DC and AC characteristics.

Operating Frequency

Oscillator Frequency f_{XX}	T_A	V_{DD}
4 MHz ≤ f_{XX} ≤ 12 MHz	−10 to +70°C	+5.0 V 10%

Capacitance

$T_A = +25°C$; $V_{DD} = V_{SS} = 0$ V

Parameter	Symbol	Max	Unit	Conditions
Input capacitance	C_I	10	pF	f = 1 MHz; unmeasured pins returned to 0 V.
Output capacitance	C_O	20	pF	
I/O capacitance	C_{IO}	20	pF	

DC Characteristics

$T_A = -10$ to $+70°C$; $V_{DD} = +5.0$ V ±5%; $V_{SS} = 0$ V

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Input low voltage	V_{IL1}	0		0.8	V	Except $\overline{EA}$ on μPD78310A/312A
	V_{IL2}	0		0.5	V	$\overline{EA}$ on μPD78310A/312A only)
Input high voltage	V_{IH1}	2.2		V_{DD}	V	Except $P2_0$/NMI, X1, X2, $\overline{RESET}$
	V_{IH2}	3.8		V_{DD}	V	$P2_0$/NMI X1, X2, $\overline{RESET}$
Output low voltage	V_{OL}			0.45	V	$I_{OL} = 2.0$ mA
Output high voltage	V_{OH}	$V_{DD} - 1$			V	$I_{OH} = -1$ mA
Input current	I_I			±10	μA	$P2_0$/NMI, $\overline{RESET}$ $V_I = 0.45$ V to V_{DD}
Input leakage current	I_{LI}			±10	μA	
Input/output leakage current	I_{LO}			±10	μA	
AV_{REF} current	AI_{REF}		1.5	5	mA	$f_{CLK} = 6$ MHz
V_{DD} supply current	I_{DD1}		30	60	mA	Operating mode; $f_{CLK} = 6$ MHz
	I_{DD2}		5	15	mA	Halt mode; $f_{CLK} = 6$ MHz
Data retention voltage	V_{DDDR}	2.5			V	Stop mode
Stop mode supply current	I_{DDDR}		3	15	μA	Stop mode; $V_{DDDR} = 2.5$ V
			10	50	μA	Stop mode; $V_{DDDR} = 5.0$ V ±10%

NEC

AC Characteristics

$T_A = -10$ to $+70°C$; $V_{DD} = +5.0$ V $\pm10\%$; $V_{SS} = 0$ V

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Read/Write Operation						
System clock cycle time	t_{CYK}	166		1000	ns	(Note 1)
Address setup time to ALE ↓	t_{SAL}	150			ns	
Address hold time after ALE ↓	t_{HLA}	30			ns	(Note 4)
Address to $\overline{RD}$ ↓ delay time	t_{DAR}	230			ns	
$\overline{RD}$ ↓ to address floating	t_{FRA}			0	ns	
Address to data input	t_{DAID}			410	ns	
ALE ↓ to data input	t_{DLID}			230	ns	
$\overline{RD}$ ↓ to data input	t_{DRID}			180	ns	
ALE ↓ to $\overline{RD}$ ↓ delay time	t_{DLR}	60			ns	
Data hold time after $\overline{RD}$ ↑	t_{HRID}	0			ns	
$\overline{RD}$ ↑ to address active	t_{DRA}	50			ns	
$\overline{RD}$ ↑ to ALE ↑ delay time	t_{DRL}	100			ns	
$\overline{RD}$ width low	t_{WRL}	200			ns	
ALE width high	t_{WLH}	120			ns	
Address to $\overline{WR}$ ↓ delay time	t_{DAW}	300			ns	
ALE ↓ to data output	t_{DLOD}			190	ns	
$\overline{WR}$ ↓ to data output	t_{DWOD}			100	ns	
ALE ↓ to $\overline{WR}$ ↓ delay time (Note 2)	t_{DLW}	30			ns	
		110			ns	During refresh mode
Data setup time to $\overline{WR}$ ↑	t_{SODWR}	150			ns	
Data setup time to $\overline{WR}$ ↓ (Note 3)	t_{SODWF}	30			ns	During refresh mode
Data hold time to $\overline{WR}$ ↑	t_{HWOD}	20			ns	(Note 4)
$\overline{WR}$ ↑ to ALE ↑ delay time	t_{DWL}	110			ns	
$\overline{WR}$ width low	t_{WWL}	200			ns	
Serial Port						
Serial clock cycle time	t_{CYSK}	1.33			μs	$\overline{SCK}$ output (Note 5)
		1.33			μs	$\overline{CTS}$ output (Note 6)
		1			μs	$\overline{CTS}$ input (Note 7)
Serial clock low-level width	t_{WSKL}	580			ns	$\overline{SCK}$ output (Note 5)
		580			ns	$\overline{CTS}$ output (Note 6)
		420			ns	$\overline{CTS}$ input (Note 7)
Serial clock high-level width	t_{WSKH}	580			ns	$\overline{SCK}$ output (Note 5)
		580			ns	$\overline{CTS}$ output (Note 6)
		420			ns	$\overline{CTS}$ input (Note 7)
$\overline{CTS}$ high, low level	t_{WCSH}, t_{WCSL}	3		t_{CYK}		Asynchronous mode
RxD setup time to $\overline{CTS}$ ↑	t_{SRXSK}	80			ns	
RxD hold time after $\overline{CTS}$ ↑	t_{HSKRX}	80			ns	
$\overline{SCK}$ ↓ to TxD delay time	t_{DSKTX}			210	ns	

5a

AC Characteristics (cont)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
A/D Converter						
$T_A = -10°C$ to $+70°C$; $V_{DD} = +5$ V $\pm10\%$; $AV_{REF} = 4.0$ V to V_{DD}; $AV_{SS} = V_{SS} = 0$ V						
Resolution		8			Bit	
Full scale error				0.4	%	$t_{CYK} = 166$ to 500 ns
Quantization error				±1/2	LSB	
Conversion time	t_{CONV}	180			t_{CYK}	$t_{CYK} = 166$ to 250 ns
		120			t_{CYK}	$t_{CYK} = 250$ to 500 ns
Sampling time	t_{SAMP}	36			t_{CYK}	$t_{CYK} = 166$ to 250 ns
		24			t_{CYK}	$t_{CYK} = 250$ to 500 ns
Analog input voltage	V_{IAN}	0		AV_{REF}	V	
Input impedance	R_{AN}		1000		MΩ	
Analog reference voltage	AV_{REF}	4.0		V_{DD}	V	
AV_{REF} current	AI_{REF}		1.5	5.0	mA	$f_{CLK} = 6$ MHz
Counter Operation						
CI0, CI1 high, low levels	t_{WCIH}, t_{WCIL}	3			t_{CYK}	
CTRL0, CRTL1 high, low levels	t_{WCTH}, t_{WCTL}	3			t_{CYK}	
CTRL0, CTRL1 setup time to CI ↑	t_{SCTCI}	2			t_{CYK}	Operating mode of count unit is set to mode 3. CI input is set to rising edge active.
CTRL0, CTRL1 hold time after CI ↑	t_{HCICT}	5			t_{CYK}	
CLR0, CLR1 high, low-level width	t_{WCRH}, t_{WCRL}	3			t_{CYK}	
CI0, CI1 setup time to CTRL	t_{S4CTCI}	6			t_{CYK}	Counter mode 4
CTRL0, CTRL1 setup time to CI	t_{H4CTCI}	6			t_{CYK}	Counter mode 4
CI0/CI1, CTRL0/CTRL1 cycle time	t_{CYC4}			250	kHz	Counter mode 4
External Interrupts and Reset						
NMI high, low-level width	t_{WNIH}, t_{WNIL}	10			μs	
INTE0 high, low-level width	t_{WI0H}, t_{WI0L}	3			t_{CYK}	
INTE1 high, low-level width	t_{WI1H}, t_{WI1L}	3			t_{CYK}	
INTE2 high, low-level width	t_{WI2H}, t_{WI2L}	3			t_{CYK}	
RESET high, low-level width	t_{WRSH}, t_{WRSL}	10			μs	
V_{DD} rise, fall time	t_{RVD}, t_{FVD}	200			μs	

Notes:

(1) The internal clock (f_{CLK}) equals the oscillation clock (f_{XX}) divided by 2 or 8 as determined by bit 5 of the STBC. In this table, $f_{XX} = 12$ MHz and $f_{CLK} = f_{XX}/2$.

(2) During refresh operation, the WR̄ signal falls to low level 1/2 clock cycle later than if there is no refresh.

(3) When accessing data from pseudostatic RAMs (e.g. μPD4168) with the falling edge of the WR̄ signal, the data setup time is t_{SODWF} instead of t_{SODWR}.

(4) Hold time is measured with $C_L = 100$ pF and $R_L = 2$ kΩ load, and includes the period necessary to guarantee V_{OH} and V_{OL}.

(5) I/O interface mode transmit data at a data rate of 750 kb/s.

(6) I/O interface mode receive data, internal clock, at a data rate of 750 kb/s.

(7) In the I/O interface mode this is the optional external clock for received data at a maximum rate of 1 MB/s.

Oscillator Characteristics

$T_A = -10$ to $70°C$; $V_{DD} = +5.0$ V $\pm 10\%$; $V_{SS} = AV_{SS} = 0$ V;
4 V $\leq AV_{REF} \leq V_{DD}$

Oscillator	Parameter	Symbol	Min	Max	Unit
Ceramic resonator or crystal resonator	Oscillation frequency	f_{XX}	4	12	MHz
External clock	X1 input frequency	f_X	4	12	MHz
	X1 input rise, fall time	t_{XR}, t_{XF}	0	30	ns
	X1 input high-low-level width	t_{WXH}, t_{WXL}	30	130	ns

Recommended Ceramic Resonators (μPD78310/312A)

Manufacturer	Part No.	Frequency (MHz)	External Capacitance (pF)	
			C1	C2
Murata Mfg. Co., Ltd.	CSA12.OMT	12.0	30	30
	CST12.OMT	12.0	Included	Included

Recommended Circuits

Ceramic Resonator or Crystal Resonator (Notes)

External Clock

X1   X2

X1   X2

C1   C2

HCMOS Inverter

Notes:

1. When using a crystal resonator, the following external capacitor is recommended:
   C1 = C2 = 15pF

2. Oscillator circuit must be located as close as possible to the X1 and X2 pins.

3. To prevent noise from affecting operation, avoid locating other signal lines within the shaded area.

83YL-6638A

Timing Dependent on t_{CYK}

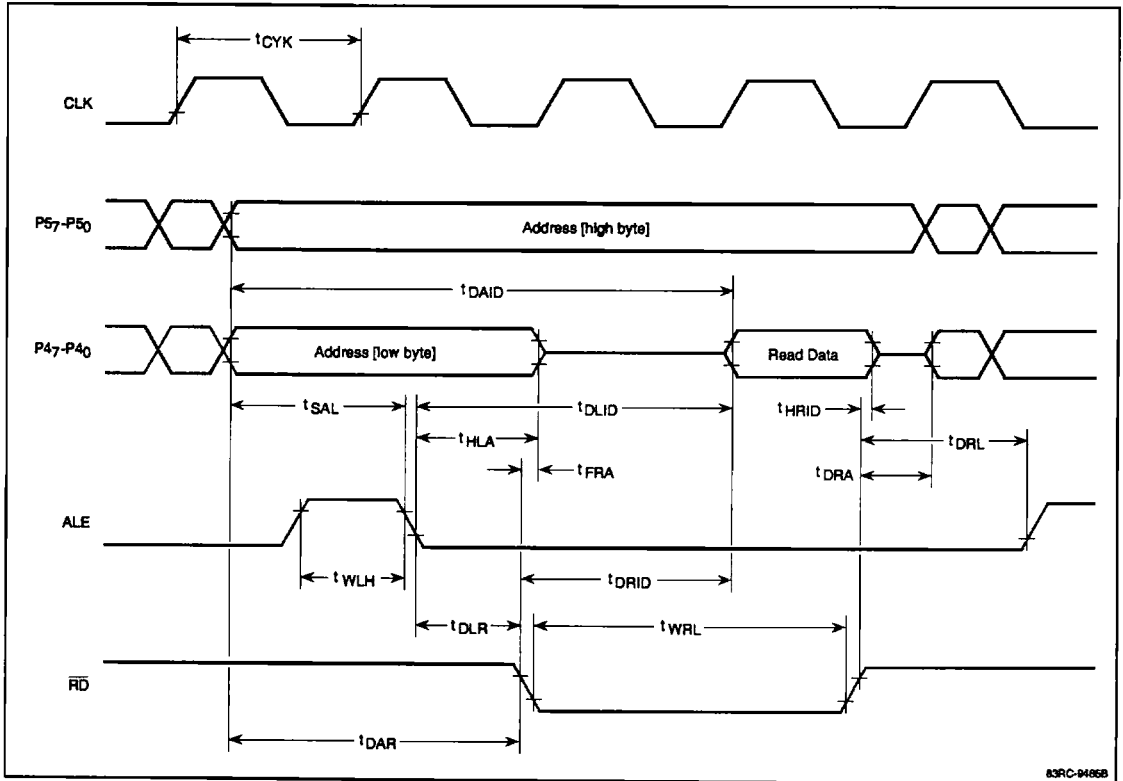| Symbol	Formula	Min/Max	Unit
t_{SAL}	$1.5T - 100$	Min	ns
t_{DAR}	$2T - 100$		
t_{DAID}	$(3.5 + n) T - 170$	Max	ns
t_{DLID}	$(2 + n) T - 100$		
t_{DRID}	$(1.5 + n) T - 70$		
t_{DLR}	$0.5T - 20$	Min	ns
t_{DRL}	$T - 50$		
t_{DRA}	$0.5T - 30$		
t_{WRL}	$(1.5 + n) T - 50$		
t_{WLH}	$T - 40$		
t_{DAW}	$2T - 100$		
t_{DLOD}	$0.5T + 110$	Max	ns
t_{DLW}	$0.5T - 20$ (normal operation)	Min	ns
	$T - 50$ (during refresh mode)		
t_{SODWR}	$(1.5 + n) T - 100$		
t_{SODWF}	$0.5T - 50$		
t_{DWL}	$T - 50$		
t_{WWL}	$(1.5 + n) - 50$		
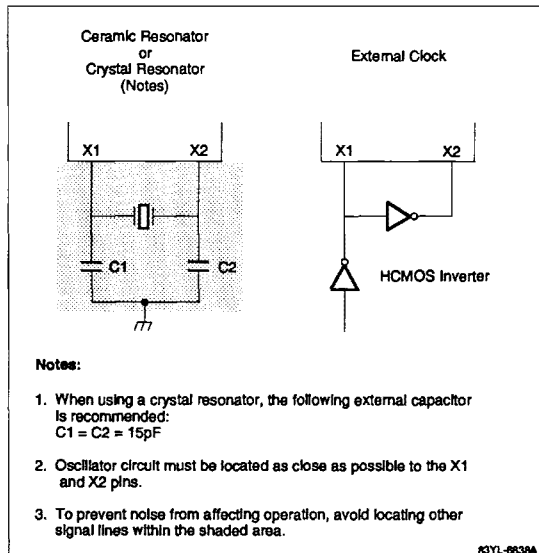
Notes:

(1) n is the number of additional wait cycles specified by the MM register.

(2) $T = t_{CYK} = 1/f_{CLK} = 2/f_{XX}$. f_{CLK} is the internal system clock frequency.

(3) Any parameter not included in this table is not dependent on f_{CLK}.

5a

Timing Waveforms
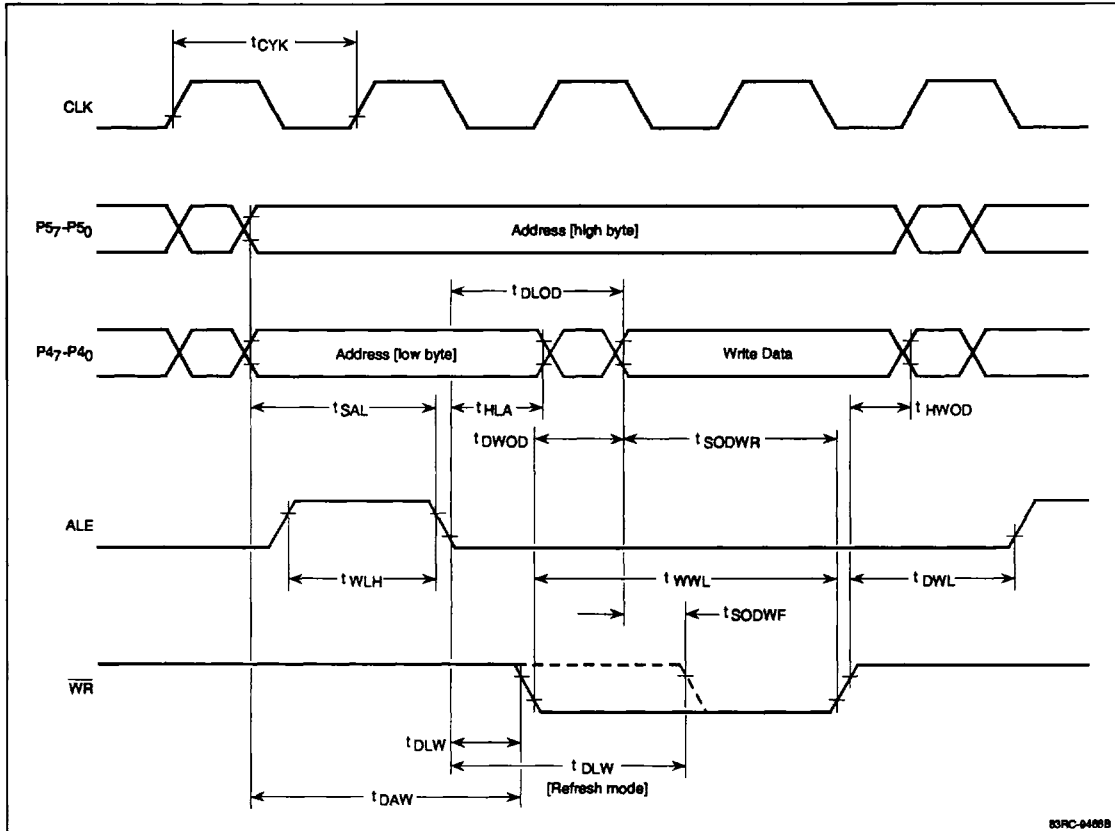
AC Timing Test Points
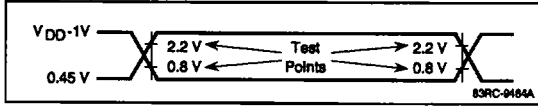
Read Operation

Timing Waveforms (cont)

Write Operation

Timing Waveforms (cont)

Serial Port, I/O Interface Mode

Data Transmit

SCK

t_{CYSK}
t_{WSKL}
t_{WSKH}
t_{DSKTX}

TxD

Data Receive

CTS

t_{CYSK}
t_{WSKL}
t_{WSKH}
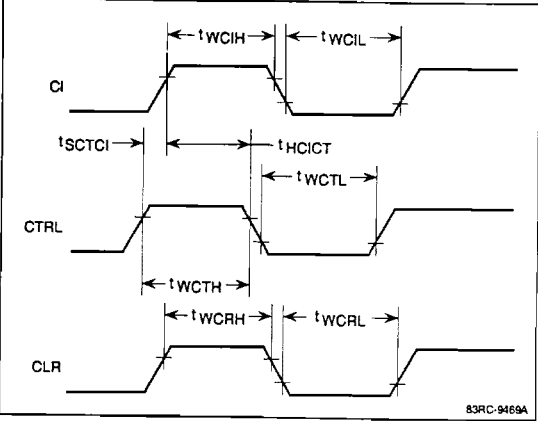t_{SRXSK}
t_{HSKRX}

RxD

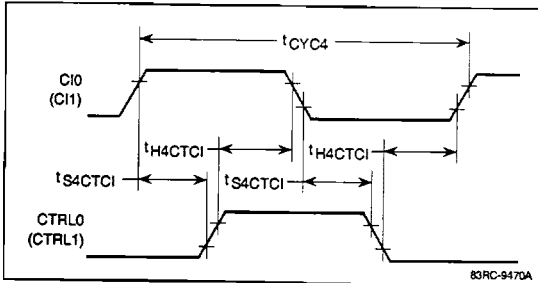83RC-9467B

NEC
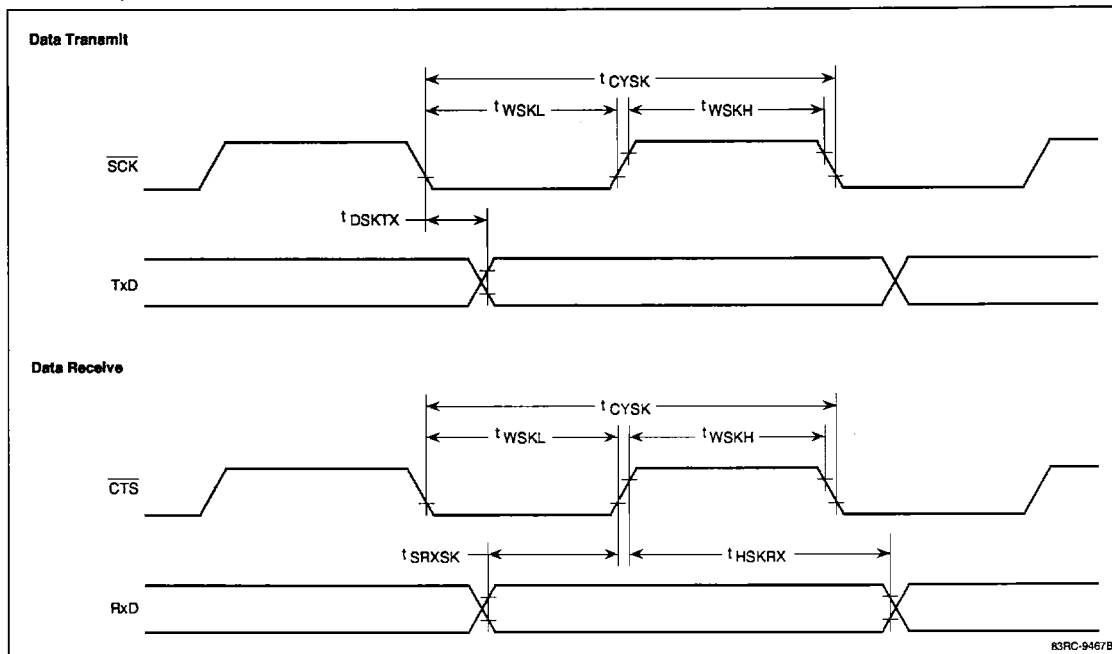
Timing Waveforms (cont)

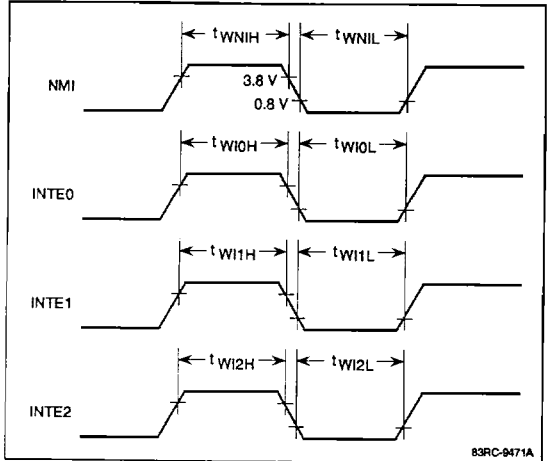### Serial Port, Asynchronous Mode Send Enable Input Timing
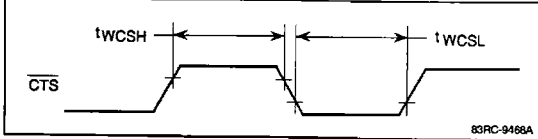
Counter Operation (Mode 3)
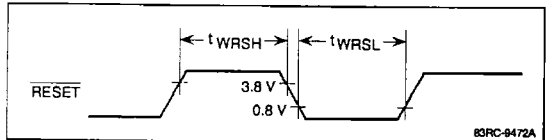

Count Timing Specification (Mode 4)
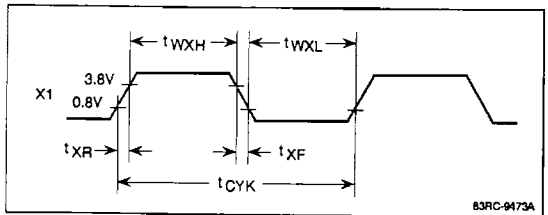

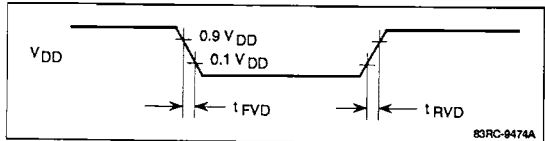### External Interrupts

External Reset

External Clock

Data Retention Timing

5a

25

PROM PROGRAMMING

The PROM in the *μ*PD78P312A is an OTP or UVE EPROM with an 8,192 x 8-bit configuration. The pins listed in the table below are used to program the PROM.

When used in the normal operation mode, 5 V ± 10% is applied to the V_{DD} and V_{PP} pins. A voltage higher than V_{DD} should not be applied to other pins.

The programming characteristics of the *μ*PD78P312A are identical to those of the *μ*PD27C256A.

Pin	Function
V_{PP}	High voltage input (write/verify mode), high-level input (read mode)
PROG	High voltage input (write/verify mode, read mode)
A_0 - A_7	Address input (lower 8 bits)
A_8 - A_{12}	Address input (upper 8 bits)
D_0 - D_7	Data input (write mode), data output (verify mode)
$\overline{CE}$	Program pulse input
$\overline{OE}$	Output enable input
V_{DD}	Power supply pin

Notes:

(1) Mask the window of the UVE EPROM version to protect the PROM from being erased accidentally.

(2) The OTP EPROM version cannot be erased by ultraviolet rays because it does not have a window.

Programming Setup

Programming socket adaptors PA-78P312CW/GF/GQ/L are used to configure the *μ*PD78P312A to fit a standard PROM socket. Set the PROM programmer to program the 27C256A. If the PROM programmer is an older model, check that the programming voltage does not exceed 12.5 volts.

Pin Functions, PROM Programming Mode

64-Pin Shrink DIP and QUIP, Plastic and Ceramic

Notes:

[1] V_{SS}: Ground this pin.

[2] Open: Do not connect this pin.

83YL-6841A
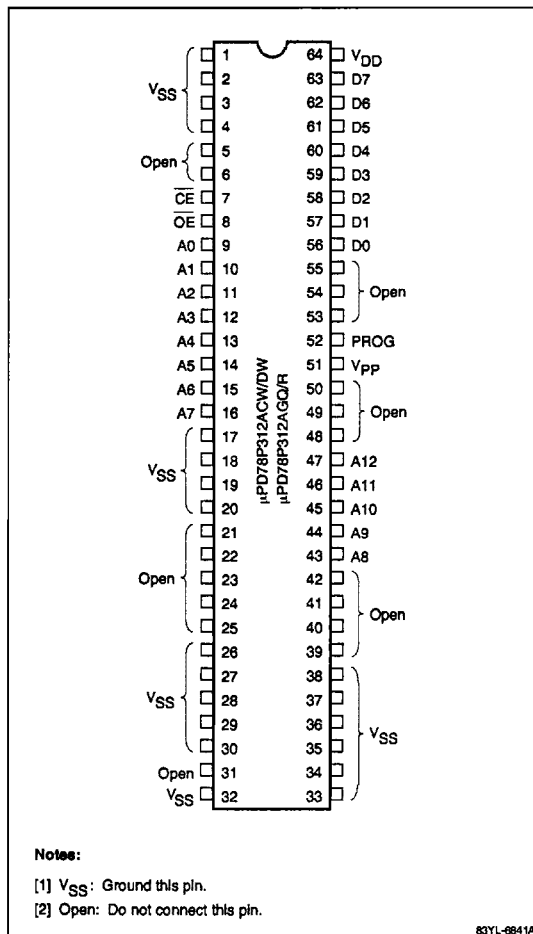
Pin Functions, PROM Programming Mode (cont)

64-Pin Plastic QFP (bent leads)

Notes:
Vss: Ground this pin
Open: Do not connect this pin

83YL-6842A
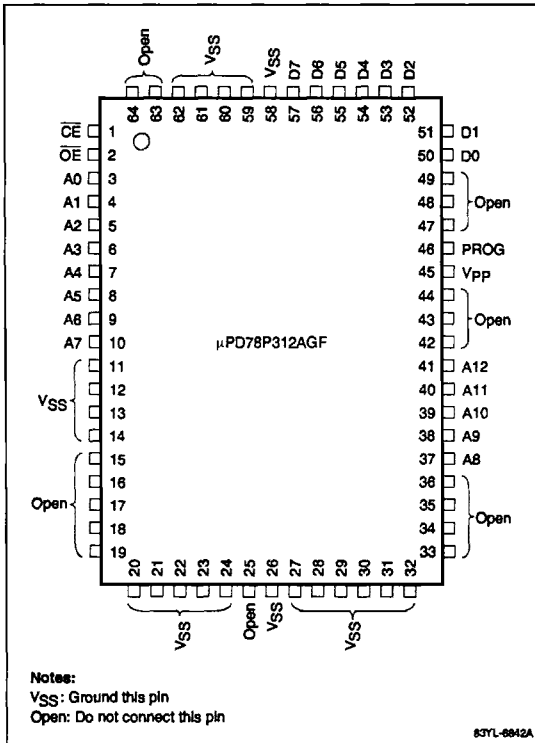
5a

Pin Functions, PROM Programming Mode (cont)

68-Pin PLCC

Notes:

[1] V_{SS}: Ground this pin.

[2] Open: Do not connect this pin.

83YL-6843B
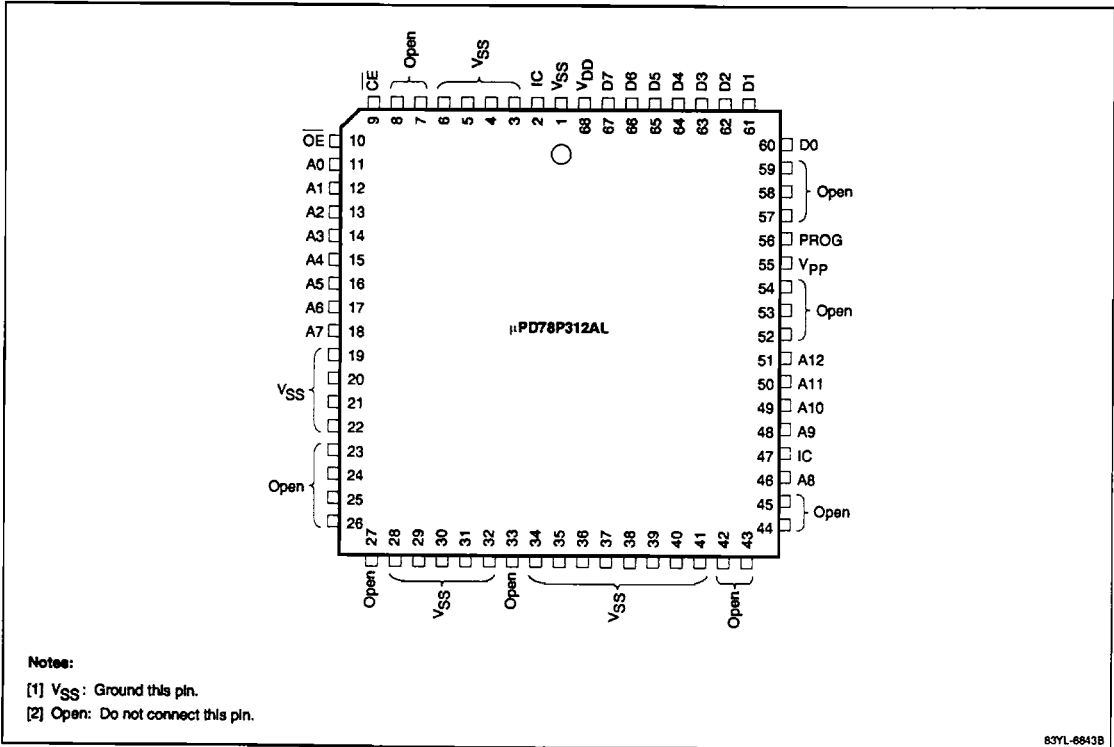
PROM Programming Mode

When +6 V is applied to the V_{DD} pin and +12.5 V is applied to the PROG pin and V_{PP} pin, the μPD78P312A enters the program write/verify mode. Operation in this mode is determined by the setting of $\overline{CE}$ and $\overline{OE}$ pins as indicated in the table below.

Mode	$\overline{CE}$	$\overline{OE}$	V_{PP}	V_{DD}	PROG
Write	L	H	+12.5 V	+6V	+12.5 V
Verify	H	L			
Program inhibit	H	H			
Read (Note 2)	L/H	L	+5 V	+5 V	+12.5 V
Read (Note 3)	L/H	H			

Notes:

(1) When +12.5 V is applied to V_{PP} and +6 V is applied to V_{DD}, both $\overline{CE}$ and $\overline{OE}$ must not be set to the low level (L) simultaneously.

(2) Data is output from the D_0 - D_7 pins.

(3) D_0 - D_7 are high impedance.

Recommended Conditions for Unused Pins

Table 3 describes how to set unused pins when programming the PROM.

Table 3. Recommended Conditions for Unused Pins

Pin	Recommended Connection
$P0_0$ - $P0_3$	Connect to V_{SS}
$P0_4$, $P0_5$	Open
$P2_0$ - $P2_3$	Connect to V_{SS}
$P2_5$ - $P2_7$, $\overline{RFSH}$	Open
$P3_0$ - $P3_3$, X1	Connect to V_{SS}
X2	Open
AN0-AN3, AV_{REF}, AV_{SS}	Connect to V_{SS}
$P3_4$ - $P3_7$, $P5_5$ - $P5_7$, $\overline{RD}$, $\overline{WR}$, ALE	Open

PROM Write Procedure

Data can be written to the PROM by using the following procedure.

(1) Set the pins not used for programming as indicated in table 3, and supply +6 V to the V_{DD} pin, and +12.5 V to the V_{PP} and PROG pins.

(2) Provide the initial address.

(3) Provide write data.

(4) Provide a 1 ms program pulse (active low) to the $\overline{CE}$ pin.

(5) Use the verify mode to test the data. If the data has been written, proceed to (7), if not, repeat steps (3) to (5). If the data cannot be correctly written in 25 attempts, go to step (6).

(6) Classify the PROM as defective and cease write operation.

(7) Provide write data and supply program pulse (for additional writing) for 3 ms times the number of repeats performed between steps (3) to (5).

(8) Increment the address.

(9) Repeat steps (3) to (8) until the last address is reached.

PROM Read Procedure

The contents of the PROM can be read out to the external data bus D_0 - D_7 by using the following procedure.

(1) Set the unused pins as indicated in table 3.

(2) Supply + 5 V to the V_{DD} pin and V_{PP} pin, and + 12.5 V to the PROG pin.

(3) Input the address of the data to be read to the A_0 to A_{12} pins.

(4) Put an active low pulse of at least 1 μs on the $\overline{OE}$ pin.

(5) Data is output to the D_0 to D_7 pins.

Erasure

The UVE EPROM can be erased by exposing the window to light having a wavelength shorter than 400 nm, including ultraviolet rays, direct sunlight, and fluorescent light. To prevent unintentional erasure, mask the window.

Typically, data is erased by 254-nm ultraviolet rays. A minimum lighting level of 15 W s/cm^2 (ultraviolet ray intensity x exposure time) is required to completely erase written data. Erasure by an ultraviolet lamp rated at 12,000 μW/cm^2 takes approximately 15 to 20 minutes. Remove any filter on the lamp and place the device within 2.5 cm of the lamp tubes.

5a

DC Programming Characteristics

$T_A = 25 \pm 5°C$; $V_{IP} = 12.0 \pm 0.5$ V; $V_{SS} = 0$ V

Parameter	Symbol	Symbol (Note)	Min	Typ	Max	Unit	Condition
High-level input voltage	V_{IH}	V_{IH}	2.2		$V_{DDP} + 0.3$	V	
Low-level input voltage	V_{IL}	V_{IL}	−0.3		0.8	V	
Input leakage current	V_{LIP}	V_{LI}			10	μA	$0 \leq V_I \leq V_{DDP}$
High-level output voltage	V_{OH}	V_{OH}	$V_{DD}-1$			V	$I_{OH} = -1.0$ mA
Low-level output voltage	V_{OL}	V_{OL}			0.45	V	$I_{OL} = 2.0$ mA
Output leakage current	I_{LO}	—			10	μA	$0 \leq V_o \leq V_{DDP}$, $\overline{OE} = V_{IH}$
PROG pin high voltage input current	I_{IP}	—			±10	μA	
V_{DDP} power supply voltage	V_{DDP}	V_{DD}	5.75	6.0	6.25	V	Program memory write mode
			4.5	5.0	5.5	V	Program memory read mode
V_{PP} power supply voltage	V_{PP}	V_{PP}	12.2	12.5	12.8	V	Program memory write mode
				$V_{PP} = V_{DDP}$		V	Program memory read mode
V_{DDP} power supply current	I_{DD}	I_{DD}		10	30	mA	Program memory write mode
				10	30	mA	Program memory read mode $\overline{CE} = V_{IL}$, $V_I = V_{IH}$
V_{PP} power supply current	I_{PP}	I_{PP}		10	30	mA	Program memory write mode $\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$
				1	100	μA	Program memory read mode

Notes:

(1) Corresponding symbols for the μPD27C256A

AC Programming Characteristics

$T_A = 25 \pm 5°C$; $V_{IP} = 12.0 \pm 0.5$ V; $V_{SS} = 0$ V

Parameter	Symbol	Symbol (Note)	Min	Typ	Max	Unit	Condition
Address setup time to $\overline{CE}$ ↓	t_{SAC}	t_{AS}	2			μs	
Data to $\overline{OE}$ ↓ delay time	t_{DDOO}	t_{OES}	2			μs	
Input data setup time to $\overline{CE}$ ↓	t_{SIDC}	t_{DS}	2			μs	
Address hold time after $\overline{CE}$ ↑	t_{HCA}	t_{AH}	2			μs	
Input data hold time after $\overline{CE}$ ↑	t_{HCID}	t_{DH}	2			μs	
Output data hold time after $\overline{OE}$ ↑	t_{HOOD}	t_{DF}	0		130	ns	
V_{PP} setup time before $\overline{CE}$ ↓	t_{SVPC}	t_{VPS}	2			μs	
V_{DDP} setup time before $\overline{CE}$ ↓	t_{SVDC}	t_{VDS}	2			μs	
Initial program pulse width	t_{WL1}	t_{PW}	0.95	1.0	1.05	ms	
Additional program pulse width	t_{WL2}	t_{OPW}	2.85		78.75	ms	
PROG high-voltage input setup time before $\overline{CE}$ ↓	t_{SPC}		2			μs	
Address to data output time	t_{DAOD}	t_{ACC}			2	μs	$\overline{OE} = V_{IL}$
$\overline{OE}$ ↓ to data output time	t_{DOOD}	t_{OE}			1	μs	
Data hold time after $\overline{OE}$ ↑	t_{HCOD}	t_{DF}	0		130	ns	
Data hold time after address not valid	t_{HAOD}	t_{OH}	0			ns	$\overline{OE} = V_{IL}$

Notes:

(1) Corresponding symbols for the μPD27C256A

NEC

PROM Write Mode Timing

Notes:

[1] V_{DDP} must be applied before V_{PP} is applied and must be removed after V_{PP} is removed.

[2] V_{PP} must not exceed +13 V including overshoot voltage.
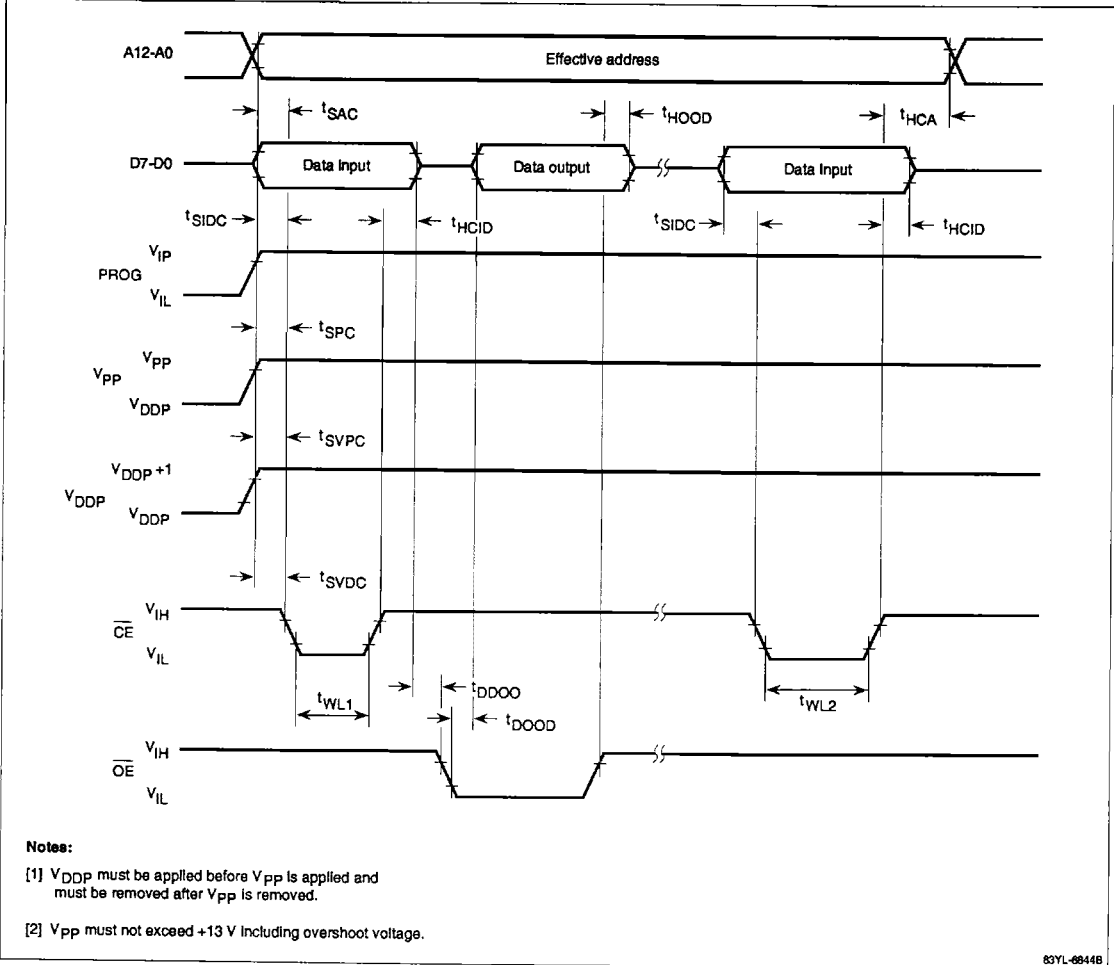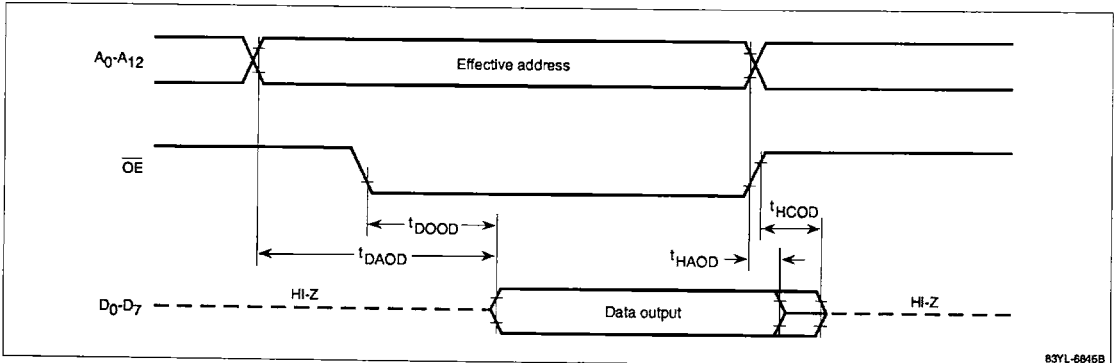
83YL-6644B

PROM Read Mode Timing

83YL-6645B

INSTRUCTION SET

The μPD78312A family instruction set features 8- and 16-bit data transfer, arithmetic, and logic instructions and single-bit manipulation instructions. String manipulation instructions are also included. Branch instructions exist to test individual bits in the program status word, the 16-bit accumulator, the special function registers, and the saddr portion of on-chip RAM. Instructions range in length from 1 to 6 bytes depending on the instruction and addressing mode.

Flag Column Indicators

Symbol	Action
(blank)	No change
0	Set to 0
1	Set to 1
X	Set or cleared according to result
P	P/V indicates parity of result
V	P/V indicates arithmetic overflow
R	Restored from saved PSW

Instruction Set Symbols

Symbol	Definition
r	R0, R1, R2, R3, R4, R5, R6, R7, R8, R9, R10, R11, R12, R13, R14, R15
r1	R0, R1, R2, R3, R4, R5, R6, R7
r2	C, B
rp	RP0, RP1, RP2, RP3, RP4, RP5, RP6, RP7*
rp1	RP0, RP1, RP2, RP3, RP4, RP5, RP6, RP7*
rp2	DE, HL, VP, UP
sfr	Special function register, 8 bits
sfrp	Special function register, 16 bits
post	RP0, RP1, RP2, RP3, RP4, RP5/PSW, RP6, RP7. Bits set to 1 indicate register pairs to be pushed/popped to/from stack; RP5 pushed/popped by PUSH/POP. SP is stack pointer; PSW pushed/popped by PUSHU/POPU, RP5 is stack pointer.
mem	Register indirect: [DE], [HL], [DE+], [HL+], [DE–], [HL–], [VP], [UP] Base Index Mode: [DE+A], [HL+A], [DE+B], [HL+B], [VP+DE], [VP+HL] Base Mode: [DE+byte], [HL+byte], [VP+byte], [UP+byte], [SP+byte] Index Mode: word [A], word [B], word [DE], word [HL]
saddr	FE20-FF1FH: Immediate byte addresses one byte in RAM, or label
saddrp	FE20-FF1FH: Immediate byte (bit 0 = 0) addresses one word in RAM, or label

Instruction Set Symbols (cont)

Symbol	Definition
word	16 bits of immediate data or label
byte	8 bits of immediate data or label
jdisp8	8-bit two's complement displacement (immediate data displacement value –128 to +127)
bit	3 bits of immediate data (bit position in byte), or label
n	3 bits of immediate data
!addr16	16-bit absolute address specified by an immediate address or label
$addr16	Relative branch address or label
addr16	16-bit address
!addr11	11-bit immediate address or label
addr11	0800H-0FFFH: 0800H + (11-bit immediate address), or label
addr5	0040H-007EH: 0040H + 2 X (5-bit immediate address), or label
A	A register (8-bit accumulator)
X	X register
B	B register
C	C register
D	D register
E	E register
H	H register
L	L register
R0-R15	Register 0 to register 15
AX	Register pair AX (16-bit accumulator)
BC	Register pair BC
DE	Register pair DE
HL	Register pair HL
RP0-RP7	Register pair 0 to register pair 7
PC	Program counter
SP	Stack pointer
UP	User stack pointer (RP5)
PSW	Program status word
PSWH	High-order 8 bits of PSW
PSWL	Low-order 8 bits of PSW
CY	Carry flag
AC	Auxiliary carry flag
Z	Zero flag
P/V	Parity/overflow flag
S	Sign flag
TPF	Table position flag

Instruction Set Symbols (cont)

Symbol	Definition
RBS	Register bank select flag
RSS	Register set select flag
IE	Interrupt enable flag
STBC	Standby control register
WDM	Watchdog timer mode register
( )	Contents of the location whose address is within parentheses; (+) and (–) indicate that the address is incremented after or decremented after it is used
(( ))	Contents of the memory location defined by the quantity within the sets of parentheses
xxH	Hexadecimal quantity
X_H, X_L	High-order 8 bits and low-order 8 bits of X

* rp and rp1 describe the same registers but generate different machine code.

5a

Instruction Set

Mnemonic	Operand	Operation	Bytes	S	Z	AC	P/V	CY	SUB
8-Bit Data Transfer									
MOV	r1, #byte	r1 ← byte	2						
	saddr, #byte	(saddr) ← byte	3						
	sfr, #byte	sfr ← byte	3						
	r, r1	r ← r1	2						
	A, r1	A ← r1	1						
	A, saddr	A ← (saddr)	2						
	saddr, A	(saddr) ← A	2						
	saddr, saddr	(saddr) ← (saddr)	3						
	A, sfr	A ← sfr	2						
	sfr, A	sfr ← A	2						
	A, mem (Note 1)	A ← (mem)	1						
	A, mem	A ← (mem)	2-4						
	mem, A (Note 1)	(mem) ← A	1						
	mem, A	(mem) ← A	2-4						
	A, [saddrp]	A ← ((saddrp))	2						
	[saddrp], A	((saddrp)) ← A	2						
	A, !addr16	A ← (addr16)	4						
	!addr16, A	(addr16) ← A	4						
	PSWL, #byte	PSWL ← byte	3	X	X	X	X	X	X
	PSWH, #byte	PSWH ← byte	3						
	PSWL, A	PSWL ← A	2	X	X	X	X	X	X
	PSWH, A	PSWH ← A	2						
	A, PSWL	A ← PSWL	2						
	A, PSWH	A ← PSWH	2						
XCH	A, r1	A ↔ r1	1						
	r, r1	r ↔ r1	2						
	A, mem	A ↔ (mem)	2-4						
	A, saddr	A ↔ (saddr)	2						
	A, sfr	A ↔ sfr	3						
	A, [saddrp]	A ↔ ((saddrp))	2						
	saddr, saddr	(saddr) ↔ (saddr)	3						
16-Bit Data Transfer									
MOVW	rp1, #word	rp1 ← word	3						
	saddrp, #word	(saddrp) ← word	4						
	sfrp, #word	sfrp ← word	4						
	rp, rp1	rp ← rp1	2						
	AX, saddrp	AX ← (saddrp)	2						
	saddrp, AX	(saddrp) ← AX	2						
	saddrp, saddrp	(saddrp) ← (saddrp)	3						

Instruction Set (cont)

Mnemonic	Operand	Operation	Bytes	S	Z	AC	P/V	CY	SUB
						Flags			
16-Bit Data Transfer (cont)									
MOVW (cont)	AX, sfrp	AX ← sfrp	2						
	sfrp, AX	sfrp ← AX	2						
	rp1, !addr16	rp1 ← (addr16)	4						
	!addr16, rp1	(addr16) ← rp1	4						
XCHW	AX, saddrp	AX ↔ (saddrp)	2						
	AX, sfrp	AX ↔ sfrp	3						
	saddrp, saddrp	(saddrp) ↔ (saddrp)	3						
	rp, rp1	rp ↔ rp1	2						
8-Bit Arithmetic									
ADD	A, #byte	A, CY ← A + byte	2	X	X	X	V	X	0
	saddr, #byte	(saddr), CY ← (saddr) + byte	3	X	X	X	V	X	0
	sfr, #byte	sfr, CY ← sfr + byte	4	X	X	X	V	X	0
	r, r1	r, CY ← r + r1	2	X	X	X	V	X	0
	A, saddr	A, CY ← A + (saddr)	2	X	X	X	V	X	0
	A, sfr	A, CY ← A + sfr	3	X	X	X	V	X	0
	saddr, saddr	(saddr), CY ← (saddr) + (saddr)	3	X	X	X	V	X	0
	A, mem	A, CY ← A + (mem)	2-4	X	X	X	V	X	0
	mem, A	(mem), CY ← (mem) + A	2-4	X	X	X	V	X	0
ADDC	A, #byte	A, CY ← A + byte + CY	2	X	X	X	V	X	0
	saddr, #byte	(saddr), CY ← (saddr) + byte + CY	3	X	X	X	V	X	0
	sfr, #byte	sfr, CY ← sfr + byte + CY	4	X	X	X	V	X	0
	r, r1	r, CY ← r + r1 + CY	2	X	X	X	V	X	0
	A, saddr	A, CY ← A + (saddr) + CY	2	X	X	X	V	X	0
	A, sfr	A, CY ← A + sfr + CY	3	X	X	X	V	X	0
	saddr, saddr	(saddr), CY ← (saddr) + (saddr) + CY	3	X	X	X	V	X	0
	A, mem	A, CY ← A + (mem) + CY	2-4	X	X	X	V	X	0
	mem, A	(mem), CY ← (mem) + A + CY	2-4	X	X	X	V	X	0
SUB	A, #byte	A, CY ← A – byte	2	X	X	X	V	X	1
	saddr, #byte	(saddr), CY ← (saddr) – byte	3	X	X	X	V	X	1
	sfr, #byte	sfr, CY ← sfr – byte	4	X	X	X	V	X	1
	r, r1	r, CY ← r – r1	2	X	X	X	V	X	1
	A, saddr	A, CY ← A – (saddr)	2	X	X	X	V	X	1
	A, sfr	A, CY ← A – sfr	3	X	X	X	V	X	1
	saddr, saddr	(saddr), CY ← (saddr) – (saddr)	3	X	X	X	V	X	1
	A, mem	A, CY ← A – (mem)	2-4	X	X	X	V	X	1
	mem, A	(mem), CY ← (mem) – A	2-4	X	X	X	V	X	1

5a

Instruction Set (cont)

Mnemonic	Operand	Operation	Bytes	S	Z	AC	P/V	CY	SUB
8-Bit Arithmetic (cont)									
SUBC	A, #byte	A, CY ← A – byte – CY	2	X	X	X	V	X	1
	saddr, #byte	(saddr), CY ← (saddr) – byte – CY	3	X	X	X	V	X	1
	sfr, #byte	sfr, CY ← sfr – byte – CY	4	X	X	X	V	X	1
	r, r1	r, CY ← r – r1 – CY	2	X	X	X	V	X	1
	A, saddr	A, CY ← A – (saddr) – CY	2	X	X	X	V	X	1
	A, sfr	A, CY ← A – sfr – CY	3	X	X	X	V	X	1
	saddr, saddr	(saddr), CY ← (saddr) – (saddr) – CY	3	X	X	X	V	X	1
	A, mem	A, CY ← A – (mem) – CY	2-4	X	X	X	V	X	1
	mem, A	(mem), CY ← (mem) – A – CY	2-4	X	X	X	V	X	1
8-Bit Logic									
AND	A, #byte	A ← A ∧ byte	2	X	X		P		0
	saddr, #byte	(saddr) ← (saddr) ∧ byte	3	X	X		P		0
	sfr, #byte	sfr ← sfr ∧ byte	4	X	X		P		0
	r, r1	r ← r ∧ r1	2	X	X		P		0
	A, saddr	A ← A ∧ (saddr)	2	X	X		P		0
	A, sfr	A ← A ∧ sfr	3	X	X		P		0
	saddr, saddr	(saddr) ← (saddr) ∧ (saddr)	3	X	X		P		0
	A, mem	A ← A ∧ (mem)	2-4	X	X		P		0
	mem, A	(mem) ← (mem) ∧ A	2-4	X	X		P		0
OR	A, #byte	A ← A ∨ byte	2	X	X		P		0
	saddr, #byte	(saddr) ← (saddr) ∨ byte	3	X	X		P		0
	sfr, #byte	sfr ← sfr ∨ byte	4	X	X		P		0
	r, r1	r ← r ∨ r1	2	X	X		P		0
	A, saddr	A ← A ∨ (saddr)	2	X	X		P		0
	A, sfr	A ← A ∨ sfr	3	X	X		P		0
	saddr, saddr	(saddr) ← (saddr) ∨ (saddr)	3	X	X		P		0
	A, mem	A ← A ∨ (mem)	2-4	X	X		P		0
	mem, A	(mem) ← (mem) ∨ A	2-4	X	X		P		0
XOR	A, #byte	A ← A ⊻ byte	2	X	X		P		0
	saddr, #byte	(saddr) ← (saddr) ⊻ byte	3	X	X		P		0
	sfr, #byte	sfr ← sfr ⊻ byte	4	X	X		P		0
	r, r1	r ← r ⊻ r1	2	X	X		P		0
	A, saddr	A ← A ⊻ (saddr)	2	X	X		P		0
	A, sfr	A ← A ⊻ sfr	3	X	X		P		0
	saddr, saddr	(saddr) ← (saddr) ⊻ (saddr)	3	X	X		P		0
	A, mem	A ← A ⊻ (mem)	2-4	X	X		P		0
	mem, A	(mem) ← (mem) ⊻ A	2-4	X	X		P		0

Instruction Set (cont)

Mnemonic	Operand	Operation	Bytes	S	Z	AC	P/V	CY	SUB
8-Bit Logic (cont)									
CMP	A, #byte	A – byte	2	X	X	X	V	X	1
	saddr, #byte	(saddr) – byte	3	X	X	X	V	X	1
	sfr, #byte	sfr – byte	4	X	X	X	V	X	1
	r, r1	r – r1	2	X	X	X	V	X	1
	A, saddr	A – (saddr)	2	X	X	X	V	X	1
	A, sfr	A – sfr	3	X	X	X	V	X	1
	saddr, saddr	(saddr) – (saddr)	3	X	X	X	V	X	1
	A, mem	A – (mem)	2-4	X	X	X	V	X	1
	mem, A	(mem) – A	2-4	X	X	X	V	X	1
16-Bit Arithmetic									
ADDW	AX, #word	AX, CY ← AX + word	3	X	X	X	V	X	0
	saddrp, #word	(saddrp), CY ← (saddrp) + word	4	X	X	X	V	X	0
	sfrp, #word	sfrp, CY ← sfrp + word	5	X	X	X	V	X	0
	rp, rp1	rp, CY ← rp + rp1	2	X	X	X	V	X	0
	AX, saddrp	AX, CY ← AX + (saddrp)	2	X	X	X	V	X	0
	AX, sfrp	AX, CY ← AX + sfrp	3	X	X	X	V	X	0
	saddrp, saddrp	(saddrp), CY ← (saddrp) + (saddrp)	3	X	X	X	V	X	0
SUBW	AX, #word	AX, CY ← AX – word	3	X	X	X	V	X	1
	saddrp, #word	(saddrp), CY ← (saddrp) – word	4	X	X	X	V	X	1
	sfrp, #word	sfrp, CY ← sfrp – word	5	X	X	X	V	X	1
	rp, rp1	rp, CY ← rp – rp1	2	X	X	X	V	X	1
	AX, saddrp	AX, CY ← AX – (saddrp)	2	X	X	X	V	X	1
	AX, sfrp	AX, CY ← AX – sfrp	3	X	X	X	V	X	1
	saddrp, saddrp	(saddrp), CY ← (saddrp) – (saddrp)	3	X	X	X	V	X	1
CMPW	AX, #word	AX – word	3	X	X	X	V	X	1
	saddrp, #word	(saddrp) – word	4	X	X	X	V	X	1
	sfrp, #word	sfrp – word	5	X	X	X	V	X	1
	rp, rp1	rp – rp1	2	X	X	X	V	X	1
	AX, saddrp	AX – (saddrp)	2	X	X	X	V	X	1
	AX, sfrp	AX – sfrp	3	X	X	X	V	X	1
	saddrp, saddrp	(saddrp) – (saddrp)	3	X	X	X	V	X	1
Multiplication/Division									
MULU	r1	AX ← A x r1	2						
DIVUW	r1	AX (quotient), r1 (remainder) ← AX ÷ r1	2						
MULUW	rp1	AX (high-order 16 bits), rp1 (low-order 16 bits) ← AX x rp1	2						
DIVUX	rp1	AXDE (quotient), rp1 (remainder) ← AXDE ÷ rp1	2						

5a

Instruction Set (cont)

Mnemonic	Operand	Operation	Bytes	S	Z	AC	P/V	CY	SUB
Increment/Decrement									
INC	r1	r1 ← r1 + 1	1	X	X	X	V		0
	saddr	(saddr) ← (saddr) + 1	2	X	X	X	V		0
DEC	r1	r1 ← r1 − 1	1	X	X	X	V		1
	saddr	(saddr) ← (saddr) − 1	2	X	X	X	V		1
INCW	rp2	rp2 ← rp2 + 1	1						
	saddrp	(saddrp) ← (saddrp) + 1	3						
DECW	rp2	rp2 ← rp2 − 1	1						
	saddrp	(saddrp) ← (saddrp) − 1	3						
Shift/Rotate									
ROR	r1, n	(CY, $r1_7$ ← $r1_0$, $r1_{m-1}$ ← $r1_m$) x n times	2				P	X	0
ROL	r1, n	(CY, $r1_0$ ← $r1_7$, $r1_{m+1}$ ← $r1_m$) x n times	2				P	X	0
RORC	r1, n	(CY ← $r1_0$, $r1_7$ ← CY, $r1_{m-1}$ ← $r1_m$) x n times	2				P	X	0
ROLC	r1, n	(CY ← $r1_7$, $r1_0$ ← CY, $r1_{m+1}$ ← $r1_m$) x n times	2				P	X	0
SHR	r1, n	(CY ← $r1_0$, $r1_7$ ← 0, $r1_{m-1}$ ← $r1_m$) x n times	2	X	X	0	P	X	0
SHL	r1, n	(CY ← $r1_7$, $r1_0$ ← 0, $r1_{m+1}$ ← $r1_m$) x n times	2	X	X	0	P	X	0
SHRW	rp1, n	(CY ← $rp1_0$, $rp1_{15}$ ← 0, $rp1_{m-1}$ ← $rp1_m$) x n times	2	X	X	0	P	X	0
SHLW	rp1, n	(CY ← $rp1_{15}$, $rp1_0$ ← 0, $rp1_{m+1}$ ← $rp1_m$) x n times	2	X	X	0	P	X	0
ROR4	[rp1]	A_{3-0} ← $(rp1)_{3-0}$, $(rp1)_{7-4}$ ← A_{3-0}, $(rp1)_{3-0}$ ← $(rp1)_{7-4}$	2						
ROL4	[rp1]	A_{3-0} ← $(rp1)_{7-4}$, $(rp1)_{3-0}$ ← A_{3-0}, $(rp1)_{7-4}$ ← $(rp1)_{3-0}$	2						
BCD Adjustment									
ADJ4		Decimal adjust accumulator	1	X	X	X	P	X	
Bit Manipulation									
MOV1	CY, saddr.bit	CY ← (saddr.bit)	3					X	
	CY, sfr.bit	CY ← sfr.bit	3					X	
	CY, A.bit	CY ← A.bit	2					X	
	CY, X.bit	CY ← X.bit	2					X	
	CY, PSWH.bit	CY ← PSWH.bit	2					X	
	CY, PSWL.bit	CY ← PSWL.bit	2					X	
	saddr.bit, CY	(saddr.bit) ← CY	3						
	sfr.bit, CY	sfr.bit ← CY	3						
	A.bit, CY	A.bit ← CY	2						
	X.bit, CY	X.bit ← CY	2						
	PSWH.bit, CY	PSWH.bit ← CY	2						
	PSWL.bit, CY	PSWL.bit ← CY	2	X	X	X	X		X

NEC

5a

Instruction Set (cont)

Mnemonic	Operand	Operation	Bytes	S	Z	AC	P/V	CY	SUB
Bit Manipulation (cont)									
AND1	CY, saddr.bit	CY ← CY ∧ (saddr.bit)	3					X	
	CY, /saddr.bit	CY ← CY ∧ (saddr.bit)	3					X	
	CY, sfr.bit	CY ← CY ∧ sfr.bit	3					X	
	CY, /sfr.bit	CY ← CY ∧ sfr.bit	3					X	
	CY, A.bit	CY ← CY ∧ A.bit	2					X	
	CY, /A.bit	CY ← CY ∧ A.bit	2					X	
	CY, X.bit	CY ← CY ∧ X.bit	2					X	
	CY, /X.bit	CY ← CY ∧ X.bit	2					X	
	CY, PSWH.bit	CY ← CY ∧ PSWH.bit	2					X	
	CY, /PSWH.bit	CY ← CY ∧ PSWH.bit	2					X	
	CY, PSWL.bit	CY ← CY ∧ PSWL.bit	2					X	
	CY, /PSWL.bit	CY ← CY ∧ PSWL.bit	2					X	
OR1	CY, saddr.bit	CY ← CY ∨ (saddr.bit)	3					X	
	CY, /saddr.bit	CY ← CY ∨ (saddr.bit)	3					X	
	CY, sfr.bit	CY ← CY ∨ sfr.bit	3					X	
	CY, /sfr.bit	CY ← CY ∨ sfr.bit	3					X	
	CY, A.bit	CY ← CY ∨ A.bit	2					X	
	CY, /A.bit	CY ← CY ∨ A.bit	2					X	
	CY, X.bit	CY ← CY ∨ X.bit	2					X	
	CY, /X.bit	CY ← CY ∨ X.bit	2					X	
	CY, PSWH.bit	CY ← CY ∨ PSWH.bit	2					X	
	CY, /PSWH.bit	CY ← CY ∨ PSWH.bit	2					X	
	CY, PSWL.bit	CY ← CY ∨ PSWL.bit	2					X	
	CY, /PSWL.bit	CY ← CY ∨ PSWL.bit	2					X	
XOR1	CY, saddr.bit	CY ← CY ⊻ (saddr.bit)	3					X	
	CY, sfr.bit	CY ← CY ⊻ sfr.bit	3					X	
	CY, A.bit	CY ← CY ⊻ A.bit	2					X	
	CY, X.bit	CY ← CY ⊻ X.bit	2					X	
	CY, PSWH.bit	CY ← CY ⊻ PSWH.bit	2					X	
	CY, PSWL.bit	CY ← CY ⊻ PSWL.bit	2					X	
SET1	saddr.bit	(saddr.bit) ← 1	2						
	sfr.bit	sfr.bit ← 1	3						
	A.bit	A.bit ← 1	2						
	X.bit	X.bit ← 1	2						
	PSWH.bit	PSWH.bit ← 1	2						
	PSWL.bit	PSWL.bit ← 1	2	X	X	X	X	X	

Instruction Set (cont)

Mnemonic	Operand	Operation	Bytes	S	Z	AC	P/V	CY	SUB
Bit Manipulation (cont)									
CLR1	saddr.bit	(saddr.bit) ← 0	2						
	sfr.bit	sfr.bit ← 0	3						
	A.bit	A.bit ← 0	2						
	X.bit	X.bit ← 0	2						
	PSWH.bit	PSWH.bit ← 0	2						
	PSWL.bit	PSWL.bit ← 0	2	X	X	X	X	X	X
NOT1	saddr.bit	(saddr.bit) ← $\overline{\text{(saddr.bit)}}$	3						
	sfr.bit	sfr.bit ← $\overline{\text{sfr.bit}}$	3						
	A.bit	A.bit ← $\overline{\text{A.bit}}$	2						
	X.bit	X.bit ← $\overline{\text{X.bit}}$	2						
	PSWH.bit	PSWH.bit ← $\overline{\text{PSWH.bit}}$	2						
	PSWL.bit	PSWL.bit ← $\overline{\text{PSWL.bit}}$	2	X	X	X	X	X	X
SET1	CY	CY ← 1	1					1	
CLR1	CY	CY ← 0	1					0	
NOT1	CY	CY ← $\overline{\text{CY}}$	1					X	
Call/Return									
CALL	!addr16	(SP–1) ← (PC + 3)$_H$, (SP – 2) ← (PC + 3)$_L$, PC ← addr16, SP ← SP – 2	3						
	rp1	(SP–1) ← (PC + 2)$_H$, (SP – 2) ← (PC + 2)$_L$, PC$_H$ ← rp1$_H$, PC$_L$ ← rp1$_L$, SP ← SP – 2	2						
	[rp1]	(SP–1) ← (PC + 2)$_H$, (SP – 2) ← (PC + 2)$_L$, PC$_H$ ← (rp1 + 1), PC$_L$ ← (rp1), SP ← SP – 2	2						
CALLF	!addr11	(SP–1) ← (PC + 2)$_H$, (SP – 2) ← (PC + 2)$_L$, PC$_{15-11}$ ← 00001, PC$_{10-0}$!addr11, SP ← SP – 2	2						
CALLT	[addr5]	(SP–1) ← (PC + 1)$_H$, (SP – 2) ← (PC + 1)$_L$, PC$_H$ ← (TPFx8000H + addr5 + 1), PC$_L$ ← (TPFx8000H + addr5), SP ← SP – 2	1						
BRK		(SP–1) ← PSWH, (SP – 2) ← PSWL, (SP – 3) ← (PC + 1)$_H$, (SP – 4) ← (PC + 1)$_L$, PC$_L$ ← (003EH), PC$_H$ ← (003FH), SP ← SP – 4, IE ← 0	1						
RET		PC$_L$ ← (SP), PC$_H$ ← (SP + 1), SP ← SP + 2	1						
RETI		PC$_L$ ← (SP), PC$_H$ ← (SP + 1), PSWL ← (SP + 2), PSWH ← (SP + 3), SP ← SP + 4, E0S ← 0	1	R	R	R	R	R	R
Stack Manipulation									
PUSH	post	{(SP – 1) ← rpp$_H$, (SP – 2) ← rpp$_L$, SP ← SP – 2} x n (Note 2)	2						
	PSW	(SP – 1) ← PSWH, (SP – 2) ← PSWL, SP ← SP – 2	1						

Instruction Set (cont)

Mnemonic	Operand	Operation	Bytes	S	Z	AC	P/V	CY	SUB
						Flags			
Stack Manipulation (cont)									
PUSHU	post	$\{(UP - 1) \leftarrow rpp_H, (UP - 2) \leftarrow rpp_L, UP \leftarrow UP - 2\} \times$ n (Note 2)	2						
POP	post	$\{rpp_L \leftarrow (SP), rpp_H \leftarrow (SP + 1), SP \leftarrow SP + 2\} \times$ n (Note 2)	2						
	PSW	$PSWL \leftarrow (SP), PSWH \leftarrow (SP + 1), SP \leftarrow SP + 2$	1	R	R	R	R	R	R
POPU	post	$\{rpp_L \leftarrow (UP), rpp_H \leftarrow (UP + 1), UP \leftarrow UP + 2\} \times$ n (Note 2)	2						
MOVW	SP, #word	$SP \leftarrow word$	4						
	SP, AX	$SP \leftarrow AX$	2						
	AX, SP	$AX \leftarrow SP$	2						
INCW	SP	$SP \leftarrow SP + 1$	2						
DECW	SP	$SP \leftarrow SP - 1$	2						
Unconditional Branch									
BR	!addr16	$PC \leftarrow !addr16$	3						
	rp1	$PC_H \leftarrow rp1_H, PC_L \leftarrow rp1_L$	2						
	[rp1]	$PC_H \leftarrow (rp1)_H, PC_L \leftarrow (rp1)_L$	2						
	$addr16	$PC \leftarrow addr\ 16$	2						
Conditional Branch									
BC or BL (Note 3)	$addr16	$PC \leftarrow \$addr\ 16$ if CY = 1	2						
BNC or BNL (Note 3)	$addr16	$PC \leftarrow \$addr\ 16$ if CY = 0	2						
BZ or BE (Note 3)	$addr16	$PC \leftarrow \$addr\ 16$ if Z = 1	2						
BNZ or BNE (Note 3)	$addr16	$PC \leftarrow \$addr\ 16$ if Z = 1	2						
BV or BPE (Note 3)	$addr16	$PC \leftarrow \$addr\ 16$ if P/V = 1	2						
BNV or BPO (Note 3)	$addr16	$PC \leftarrow \$addr\ 16$ if P/V = 0	2						
BN	$addr16	$PC \leftarrow \$addr\ 16$ if S = 1	2						
BP	$addr16	$PC \leftarrow \$addr\ 16$ if S = 0	2						
BGT	$addr16	$PC \leftarrow \$addr\ 16$ if (P/V $\veebar$ S) $\vee$ Z = 0	3						
BGE	$addr16	$PC \leftarrow \$addr\ 16$ if P/V $\veebar$ S = 0	3						
BLT	$addr16	$PC \leftarrow \$addr\ 16$ if P/V $\veebar$ S = 1	3						
BLE	$addr16	$PC \leftarrow \$addr\ 16$ if (P/V $\veebar$ S) $\vee$ Z = 1	3						
BH	$addr16	$PC \leftarrow \$addr\ 16$ if Z $\vee$ CY = 0	3						
BNH	$addr16	$PC \leftarrow \$addr\ 16$ if Z $\vee$ CY = 1	3						

5a

Instruction Set (cont)

Mnemonic	Operand	Operation	Bytes	S	Z	AC	P/V	CY	SUB
						Flags			
Conditional Branch (cont)									
BT	saddr.bit, $addr16	PC ← $addr 16 if (saddr.bit) = 1	3						
	sfr.bit, $addr16	PC ← $addr 16 if sfr.bit = 1	4						
	A.bit, $addr16	PC ← $addr 16 if A.bit = 1	3						
	X.bit, $addr16	PC ← $addr 16 if X.bit = 1	3						
	PSWH.bit, $addr16	PC ← $addr 16 if PSWH.bit = 1	3						
	PSWL.bit, $addr16	PC ← $addr 16 if PSWL.bit = 1	3						
BF	saddr.bit, $addr16	PC ← $addr 16 if (saddr.bit) = 0	4						
	sfr.bit, $addr16	PC ← $addr 16 if sfr.bit = 0	4						
	A.bit, $addr16	PC ← $addr 16 if A.bit = 0	3						
	X.bit, $addr16	PC ← $addr 16 if X.bit = 0	3						
	PSWH.bit, $addr16	PC ← $addr 16 if PSWH.bit = 0	3						
	PSWL.bit, $addr16	PC ← $addr 16 if PSWL.bit = 0	3						
BTCLR	saddr.bit, $addr16	PC ← $addr 16 if (saddr.bit) = 1 then reset (saddr.bit)	4						
	sfr.bit, $addr16	PC ← $addr 16 if sfr.bit = 1 then reset sfr.bit	4						
	A.bit, $addr16	PC ← $addr 16 if A.bit = 1 then reset A.bit	3						
	X.bit, $addr16	PC ← $addr 16 if X.bit = 1 then reset X.bit	3						
	PSWH.bit, $addr16	PC ← $addr 16 if PSWH.bit = 1 then reset PSWH.bit	3						
	PSWL.bit, $addr16	PC ← $addr 16 if PSWL.bit = 1 then reset PSWL.bit	3	X	X	X	X	X	X
BFSET	saddr.bit, $addr16	PC ← $addr 16 if (saddr.bit) = 0 then set (saddr.bit)	4						
	sfr.bit, $addr16	PC ← $addr 16 if sfr.bit = 0 then set sfr.bit	4						
	A.bit, $addr16	PC ← $addr 16 if A.bit = 0 then set A.bit	3						
	X.bit, $addr16	PC ← $addr 16 if X.bit = 0 then set X.bit	3						
	PSWH.bit, $addr16	PC ← $addr 16 if PSWH.bit = 0 then set PSWH.bit	3						
	PSWL.bit, $addr16	PC ← $addr 16 if PSWL.bit = 0 then set PSWL.bit	3	X	X	X	X	X	X
DBNZ	r2, $addr16	r2 ← r2 − 1, then PC ← $addr 16 if (r2) ≠ 0	2						
	saddr, $addr16	(saddr) ← (saddr) − 1, then PC ← $addr 16 if (saddr) ≠ 0	3						
Context Switching									
BRKCS	RBn	RBS$_{2-0}$ ← n, PC$_H$ ↔ R5, PC$_L$ ↔ R4, R7 ← PSWH, R6 ← PSWL, RSS ← 0, IE ← 0	2						
RETCS	!addr16	PC$_H$ ← R5, PC$_L$ ← R4, R5 ← !addr16$_H$, R4 ← !addr16$_L$, PSWH ← R7, PSWL ← R6, EOS ← 0	3	R	R	R	R	R	R

Instruction Set (cont)

Mnemonic	Operand	Operation	Bytes	S	Z	AC	P/V	CY	SUB
String Manipulation									
MOVM	[DE+], A	(DE+) ← A, C ← C–1 End if C = 0	2						
	[DE–], A	(DE–) ← A, C ← C–1 End if C = 0	2						
MOVBK	[DE+], [HL+]	(DE+) ← (HL+), C ← C–1 End if C = 0	2						
	[DE–], [HL–]	(DE–) ← (HL–), C ← C–1 End if C = 0	2						
XCHM	[DE+], A	(DE+) ↔ A, C ← C–1 End if C = 0	2						
	[DE–], A	(DE–) ↔ A, C ← C–1 End if C = 0	2						
XCHBK	[DE+], [HL+]	(DE+) ↔ (HL+), C ← C–1 End if C = 0	2						
	[DE–], [HL–]	(DE–) ↔ (HL–), C ← C–1 End if C = 0	2						
CMPME	[DE+], A	(DE+) – A, C ← C–1 End if C = 0 or Z = 0	2	X	X	X	V	X	1
	[DE–], A	(DE–) – A, C ← C–1 End if C = 0 or Z = 0	2	X	X	X	V	X	1
CMPBKE	[DE+], [HL+1]	(DE+) – (HL+), C ← C–1 End if C = 0 or Z = 0	2	X	X	X	V	X	1
	[DE–], [HL–]	(DE–) – (HL–), C ← C–1 End if C = 0 or Z = 0	2	X	X	X	V	X	1
CMPMNE	[DE+], A	(DE+) – A, C ← C–1 End if C = 0 or Z = 1	2	X	X	X	V	X	1
	[DE–], A	(DE–) – A, C ← C–1 End if C = 0 or Z = 1	2	X	X	X	V	X	1
CMPBKNE	[DE+], [HL+]	(DE+) – (HL+), C ← C–1 End if C = 0 or Z = 1	2	X	X	X	V	X	1
	[DE–], [HL–]	(DE–) – (HL–), C ← C–1 End if C = 0 or Z = 1	2	X	X	X	V	X	1
CMPMC	[DE+], A	(DE+) – A, C ← C–1 End if C = 0 or CY = 0	2	X	X	X	V	X	1
	[DE–], A	(DE–) – A, C ← C–1 End if C = 0 or CY = 0	2	X	X	X	V	X	1
CMPBKC	[DE+], [HL+1]	(DE+) – (HL+), C ← C–1 End if C = 0 or CY = 0	2	X	X	X	V	X	1
	[DE–], [HL–]	(DE–) – (HL–), C ← C–1 End if C = 0 or CY = 0	2	X	X	X	V	X	1
CMPMNC	[DE+], A	(DE+) – A, C ← C–1 End if C = 0 or CY = 1	2	X	X	X	V	X	1
	[DE–], A	(DE–) – A, C ← C–1 End if C = 0 or CY = 1	2	X	X	X	V	X	1
CMPBKNC	[DE+], [HL+]	(DE+) – (HL+), C ← C–1 End if C = 0 or CY = 1	2	X	X	X	V	X	1
	[DE–], [HL–]	(DE–) – (HL–), C ← C–1 End if C = 0 or CY = 1	2	X	X	X	V	X	1
CPU Control									
MOV	STBC, #byte	STBC ← byte	4						
	WDM, #byte	WDM ← byte	4						
SWRS		RSS ← $\overline{\text{RSS}}$	1						
SEL	RBn	RBS$_{2-0}$ ← n, RSS ← 0	2						
	RBn, ALT	RBS$_{2-0}$ ← n, RSS ← 1	2						
NOP		No operation	1						
EI		IE ← 1 (Enable interrupt)	1						
DI		IE ← 0 (Disable interrupt)	1						

Notes:

(1) One byte move instruction when [DE], [HL], [DE+], [DE–], [HL+], or [HL–] is specified for mem.

(2) rpp refers to register pairs specified in post byte. "n" is the number of register pairs specified in post byte.

(3) Either of the two mnemonics may be used.

5a